Regarding the change of names mentioned in the document, such as Hitachi Electric and Hitachi XX, to Renesas Technology Corp.

The semiconductor operations of Mitsubishi Electric and Hitachi were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Hitachi, Hitachi, Ltd., Hitachi Semiconductors, and other Hitachi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

Renesas Technology Home Page: http://www.renesas.com

Rene
Custo
April

Renesas Technology Corp. Customer Support Dept. April 1, 2003



Cautions

Keep safety first in your circuit designs!

(iii) prevention against any malfunction or mishap.

Renesas Technology Corporation puts the maximum effort into making semiconductor products better
and more reliable, but there is always the possibility that trouble may occur with them. Trouble with
semiconductors may lead to personal injury, fire or property damage.
 Remember to give due consideration to safety when making your circuit designs, with appropriate
measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or

Notes regarding these materials

- 1. These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corporation product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corporation or a third party.
- 2. Renesas Technology Corporation assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
- 3. All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corporation without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corporation or an authorized Renesas Technology Corporation product distributor for the latest product information before purchasing a product listed herein.
 - The information described here may contain technical inaccuracies or typographical errors. Renesas Technology Corporation assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.
 - Please also pay attention to information published by Renesas Technology Corporation by various means, including the Renesas Technology Corporation Semiconductor home page (http://www.renesas.com).
- 4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Renesas Technology Corporation assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.
- 5. Renesas Technology Corporation semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corporation or an authorized Renesas Technology Corporation product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
- 6. The prior written approval of Renesas Technology Corporation is necessary to reprint or reproduce in whole or in part these materials.
- 7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.
 - Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
- 8. Please contact Renesas Technology Corporation for further details on these materials or the products contained therein.



Rev. 6.0 Sept. 1998

Description

The HD404054 Series and HD404094 Series are HMCS400-series microcomputers designed to increase program productivity with large-capacity memory. Each microcomputer has three timers, one serial interface, comparator, input capture circuit.

The HD404054 Series includes three chips: the HD404052 with 2-kword ROM; the HD404054 with 4-kword ROM; and the HD4074054 with 4-kword PROM (ZTAT[™] version). Also, the HD404094 Series includes three chips: the HD404092 with 2-kword ROM; the HD404094 with 4-kword ROM; and the HD4074094 with 4-kword PROM (ZTAT[™] version).

The HD4074054 and HD4074094 are PROM version (ZTAT™ microcomputers). Program can be written to the PROM by a PROM writer, which can dramatically shorten system development periods and smooth the process from debugging to mass production. (The ZTAT™version is 27256-compatible.)

Features

• The differences between HD404054 Series and HD404094 Series

	HD404054 Series	Н	D40409 <mark>4 Series</mark>
I/O pins	10 large-current output pins: Six 15-mA sinks and four 10-mA sources	•	6 largecurrent output pins: Two 15-mA sinks and four 10-mA sources
		•	4 intermediate voltage output pins

- 27 I/O pins and 8 dedicated input pins
- Three timer/counters
- Eight-bit input capture circuit
- Two timer outputs (including two PWM outputs)
- One event counter inputs (including one double-edge function)
- One clock-synchronous 8-bit serial interface
- Comparator (2 channels)
- Built-in oscillators
 - Main clock: Ceramic or crystal oscillator (an external clock is also possible)

- Six interrupt sources
 - Two by external sources
 - Four by internal sources
- Subroutine stack up to 16 levels, including interrupts
- Two low-power dissipation modes
 - Standby mode
 - Stop mode
- One external input for transition from stop mode to active mode
- Instruction cycle time: $1 \mu s$ ($f_{OSC} = 4 \text{ MHz at } 1/4 \text{ division ratio}$)
 - 1/4, or 1/32 division ratio can be selected by hardware
- Two operating modes
 - MCU mode
 - MCU/PROM mode (HD4074054, HD4074094)

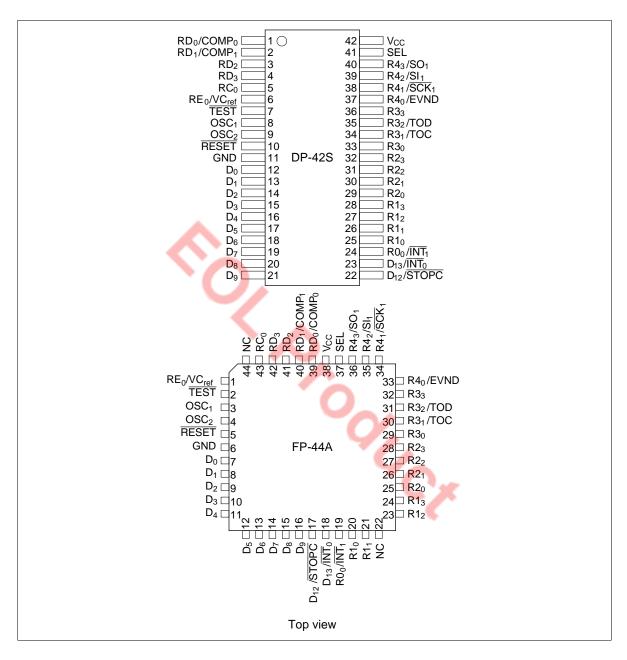
Ordering Information

Product Name

Туре	HD404054 Series	HD404094 Series	ROM (words)	RAM (digit)	Package
Mask ROM	HD404052H	HD404092H	2,048	512	FP-44A
	HD404052S	HD404092S	_		DP-42S
	HD40A4052H				FP-44A
	HD40A4052S				DP-42S
	HD404054H	HD404094H	4,096		FP-44A
	HD404054S	HD404094S			DP-42S
	HD40A4054H		_		FP-44A
	HD40A4054S			- 1	DP-42S
ZTAT™	HD4074054H	HD4074094H	4,096	C	FP-44A
	HD4074054S	HD4074094S			DP-42S

ZTAT™: Zero Turn Around Time ZTAT is a trademark of Hitachi, Ltd.

Pin Arrangement



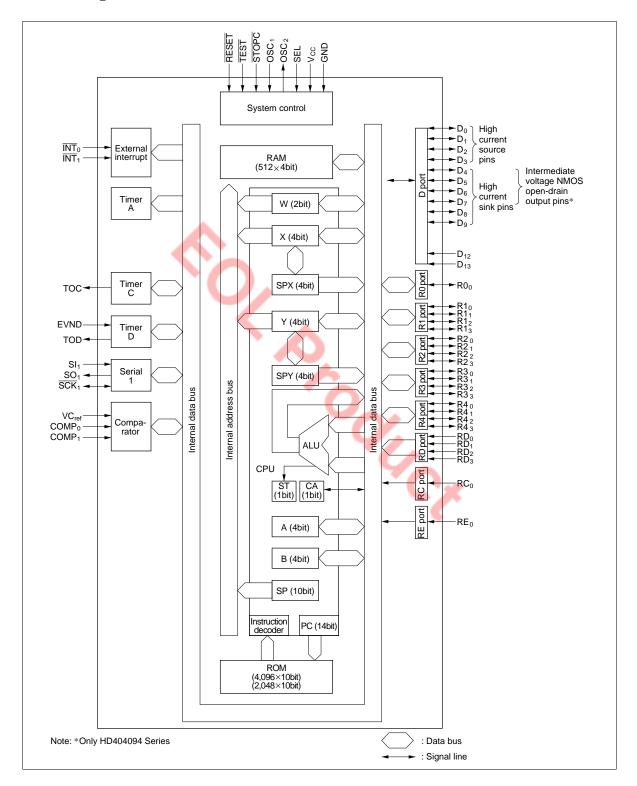
Pin Description

Pin	N	lum	her
		ulli	DEI

Item	Symbol	DP-42S	FP-44A	I/O	Function
Power supply	V _{cc}	42	38		Applies power voltage
	GND	11	6		Connected to ground
Test	TEST	7	2	I	Used for factory testing only: Connect this pin to V_{cc}
Reset	RESET	10	5	I	Resets the MCU
Oscillator	OSC ₁	8	3	I	_
	OSC ₂	9	4	0	_
Port	D ₀ -D ₉	12–21	7–16	I/O*	Input/output pins addressed by individual bits; pins D_0 – D_3 are high-current source pins that can each supply up to 10 mA.
					The HD404054 Series: pins D ₄ –D ₉ are high-current sink pins that can each supply up to 15mA.
		(ヤ		The HD404094 Series: D_4 – D_7 are intermediate voltage (12 V) NMOS open-drain pins, and D_8 , D_9 are high-current sink pins that can each supply up to 15 mA.
	D ₁₂ ,D ₁₃	22, 23	17, 18		Input pins addressable by individual bits
	R0 ₀ -R4 ₃	24-40	19–36	I/O	Input/output pins addressable in 4-bit units
	RD ₀ -RD ₃ ,	1–6	39–43,1	1	Input pins addressable in 4-bit units
	RC ₀ , RE ₀				
Interrupt	\overline{INT}_{0} , \overline{INT}_{1}	23, 24	18, 19	I	Input pins for external interrupts
Stop clear	STOPC	22	17	I	Input pin for transition from stop mode to active mode
Serial	SCK₁	38	34	I/O	Serial clock input/output pin
	SI ₁	39	35	I	Serial receive data input pin
	SO ₁	40	36	0	Serial transmit data output pin
Timer	TOC, TOD	34, 35	30, 31	0	Timer output pins
	EVND	37	33	I	Event count input pins
Comparator	COMP ₀ ,	1, 2	39, 40	I	Analog input pins for voltage comparator
	VC _{ref}	6	1		Reference voltage pin for inputting the threshold voltage of the analog input pin.
Division rate	SEL	41	37	I	Input pin for selecting system clock division rate after RESET input or after stop mode cancellation.
					1/4 division rate: Connect it to V_{cc}
					1/32 division rate: Connect it to GND

Note: $*D_4-D_7$ of the HD404094 Series are output pins.

Block Diagram



Memory Map

ROM Memory Map

The ROM memory map is shown in figure 1 and described below.

Vector Address Area (\$0000–\$000F): Reserved for JMPL instructions that branch to the start addresses of the reset and interrupt routines. After MCU reset or an interrupt, program execution continues from the vector address.

Zero-Page Subroutine Area (\$0000–\$003F): Reserved for subroutines. The program branches to a subroutine in this area in response to the CAL instruction.

Pattern Area (\$0000-\$0FFF): Contains ROM data that can be referenced with the P instruction.

Program Area (\$0000-\$07FF (HD404052, HD40A4052, HD404092), \$0000-\$0FFF (HD404054, HD40A4054, HD4074054, HD4074094); Used for program coding.

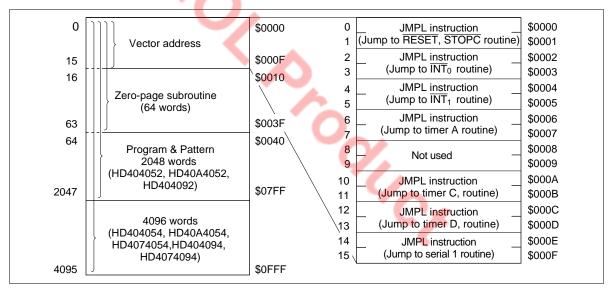


Figure 1 ROM Memory Map

RAM Memory Map

The MCU contains a 512-digit × 4-bit RAM area consisting of a memory register area, a data area, and a stack area. In addition, an interrupt control bits area, special register area, and register flag area are mapped onto the same RAM memory space as a RAM-mapped register area outside the above areas. The RAM memory map is shown in figure 2 and described as follows.

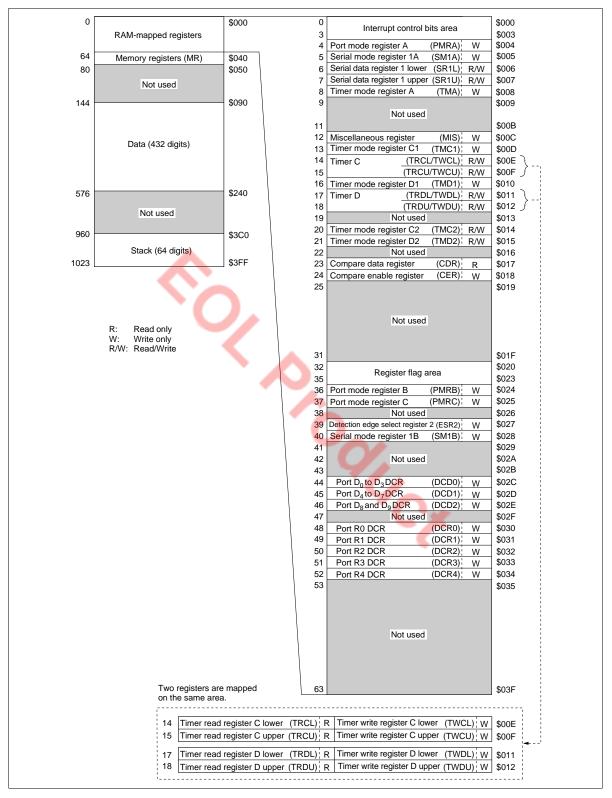


Figure 2 RAM Memory Map

RAM-Mapped Register Area (\$000-\$03F):

- Interrupt Control Bits Area (\$000–\$003)
 - This area is used for interrupt control bits (figure 3). These bits can be accessed only by RAM bit manipulation instructions (SEM/SEMD, REM/REMD, and TM/TMD). However, note that not all the instructions can be used for each bit. Limitations on using the instructions are shown in figure 4.
- Special Function Register Area (\$004–\$018, \$024–\$034)

 This area is used as mode registers and data registers for external interrupts, serial interface 1, timer/counters, voltage comparator, and as data control registers for I/O ports. The structure is shown in figures 2 and 5. These registers can be classified into three types: write-only (W), read-only (R), and read/write (R/W). RAM bit manipulation instructions cannot be used for these registers.
- Register Flag Area (\$020–\$023)

This area is used for the WDON, and other register flags and interrupt control bits (figure 3). These bits can be accessed only by RAM bit manipulation instructions (SEM/SEMD, REM/REMD, and TM/TMD). However, note that not all the instructions can be used for each bit. Limitations on using the instructions are shown in figure 4.

Memory Register (MR) Area (\$040–\$04F): Consisting of 16 addresses, this area (MR0–MR15) can be accessed by register-register instructions (LAMR and XMRA). The structure is shown in figure 6.

Data Area (\$090–\$23F): 432 digits from \$090 to \$23F.

Stack Area (\$3C0-\$3FF): Used for saving the contents of the program counter (PC), status flag (ST), and carry flag (CA) at subroutine call (CAL or CALL instruction) and for interrupts. This area can be used as a 16-level nesting subroutine stack in which one level requires four digits. The data to be saved and the save conditions are shown in figure 6.

The program counter is restored by either the RTN or RTNI instruction, but the status and carry flags can only be restored by the RTNI instruction. Any unused space in this area is used for data storage.

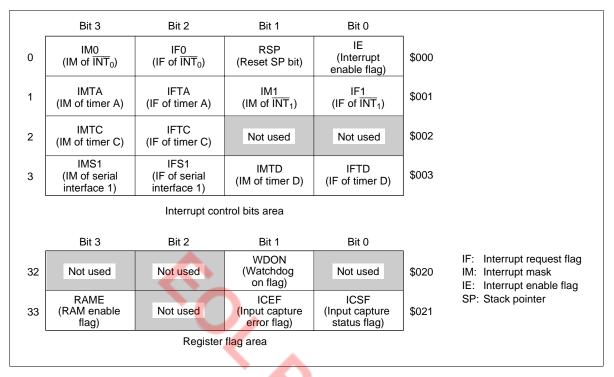


Figure 3 Configuration of Interrupt Control Bits and Register Flag Areas

	SEM/SEMD	REM/REMD	TM/TMD	
IE	Allowed	Allowed	Allowed	
IM	Allowed	Allowed	Allowed	
IF				
ICSF	Not executed	Allowed	Allowed	
ICEF	Not executed	Alloweu	Allowed	
RAME			X	
RSP	Not executed	Allowed	Inhibited	
WDON	Allowed	Not executed	Inhibited	
Not used	Not executed	Not executed	Inhibited	

Note: WDON is reset by MCU reset or by STOPC enable for stop mode cancellation. If the TM or TDM instruction is executed for the inhibited bits or non-existing bits, the value in ST becomes invalid.

Figure 4 Usage Limitations of RAM Bit Manipulation Instructions

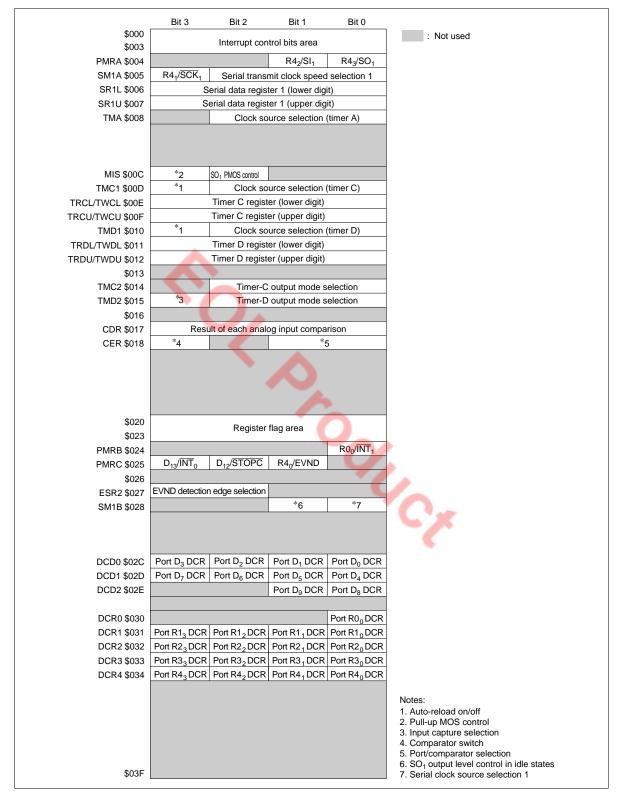


Figure 5 Special Function Register Area

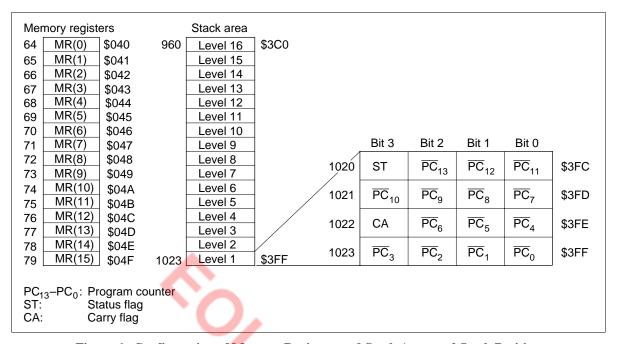


Figure 6 Configuration of Memory Registers and Stack Area, and Stack Position

Functional Description

Registers and Flags

The MCU has nine registers and two flags for CPU operations. They are shown in figure 7 and described below.

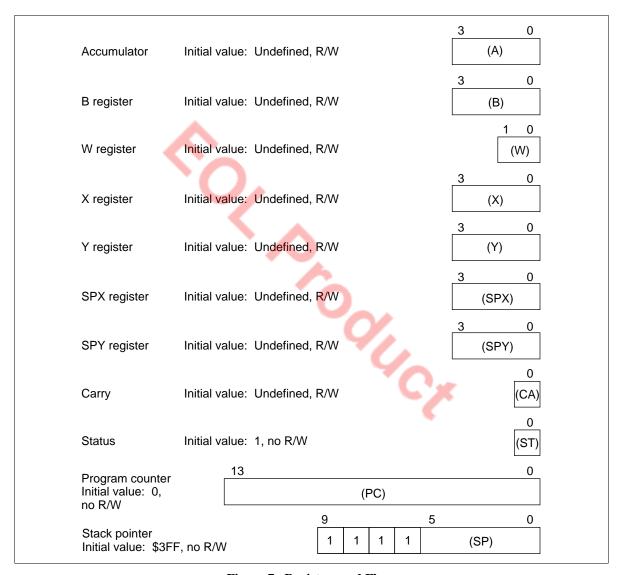


Figure 7 Registers and Flags

Accumulator (**A**), **B Register** (**B**): Four-bit registers used to hold the results from the arithmetic logic unit (ALU) and transfer data between memory, I/O, and other registers.

W Register (W), X Register (X), Y Register (Y): Two-bit (W) and four-bit (X and Y) registers used for indirect RAM addressing. The Y register is also used for D-port addressing.

SPX Register (SPX), SPY Register (SPY): Four-bit registers used to supplement the X and Y registers.

Carry Flag (CA): One-bit flag that stores any ALU overflow generated by an arithmetic operation. CA is affected by the SEC, REC, ROTL, and ROTR instructions. A carry is pushed onto the stack during an interrupt and popped from the stack by the RTNI instruction-but not by the RTN instruction.

Status Flag (ST): One-bit flag that latches any overflow generated by an arithmetic or compare instruction, not-zero decision from the ALU, or result of a bit test. ST is used as a branch condition of the BR, BRL, CAL, and CALL instructions. The contents of ST remain unchanged until the next arithmetic, compare, or bit test instruction is executed, but become 1 after the BR, BRL, CAL, or CALL instruction is read, regardless of whether the instruction is executed or skipped. The contents of ST are pushed onto the stack during an interrupt and popped from the stack by the RTNI instruction—but not by the RTN instruction.

Program Counter (PC): 14-bit binary counter that points to the ROM address of the instruction being executed.

Stack Pointer (SP): Ten-bit pointer that contains the address of the stack area to be used next. The SP is initialized to \$3FF by MCU reset. It is decremented by 4 when data is pushed onto the stack, and incremented by 4 when data is popped from the stack. The top four bits of the SP are fixed at 1111, so a stack can be used up to 16 levels.

The SP can be initialized to \$3FF in another way: by resetting the RSP bit with the REM or REMD instruction.

Reset

The MCU is reset by inputting a high-level voltage to the \overline{RESET} pin. At power-on or when stop mode is cancelled, \overline{RESET} must be high for at least one t_{RC} to enable the oscillator to stabilize. During operation, \overline{RESET} must be high for at least two instruction cycles.

Initial values after MCU reset are listed in table 1.

Table 1 Initial Values After MCU Reset

Item		Abbr.	Initial Value	Contents
Program cou	nter	(PC)	\$0000	Indicates program execution point from start address of ROM area
Status flag		(ST)	1	Enables conditional branching
Stack pointer	ſ	(SP)	\$3FF	Stack level 0
Interrupt	Interrupt enable flag	(IE)	0	Inhibits all interrupts
flags/mask	Interrupt request flag	(IF)	0	Indicates there is no interrupt request
	Interrupt mask	(IM)	1	Prevents (masks) interrupt requests
I/O	Port data register	(PDR)	All bits 1	Enables output at level 1
	Data control register	(DCD0 – DCD2)	All bits 0	Turns output buffer off (to high impedance)
		(DCR0- DCR4)	All bits 0	-
	Port mode register A	(PMRA)	00	Refer to description of port mode register A
	Port mode register B	(PMRB)	0	Refer to description of port mode register B
	Port mode register C bits 3, 2, 1	(PMRC3, PMRC2, PMRC1)	000 -	Refer to description of port mode register C
	Detection edge select register 2	(ESR2)	00	Disables edge detection
Timer/	Timer mode register A	(TMA)	- 000	Refer to description of timer mode register A
counters,	Timer mode register C1	(TMC1)	0000	Refer to description of timer mode register C1
serial	Timer mode register C2	(TMC2)	- 000	Refer to description of timer mode register C2
interface	Timer mode register D1	(TMD1)	0000	Refer to description of timer mode register D1
	Timer mode register D2	(TMD2)	0000	Refer to description of timer mode register D2
	Serial mode register 1A	(SM1A)	0000	Refer to description of serial mode register 1A
	Serial mode register 1B	(SM1B)	X0	Refer to description of serial mode register 1B
	Prescaler S	(PSS)	\$000	_
	Timer counter A	(TCA)	\$00	_
	Timer counter C	(TCC)	\$00	_
	Timer counter D	(TCD)	\$00	
	Timer write register C	(TWCU, TWCL)	\$X0	_
	Timer write register D	(TWDU,	\$X0	_
	Octal counter	TWDL)	000	_
Comparator	Compare enable register	(CER)	0 - 00	Refer to description of voltage comparator

			Initial	
Item		Abbr.	Value	Contents
Bit register	Watchdog timer on flag	(WDON)	0	Refer to description of timer C
	Input capture status flag	(ICSF)	0	Refer to description of timer D
	Input capture error flag	(ICEF)	0	Refer to description of timer D
Others	Miscellaneous register	(MIS)	00	Refer to description of operating modes, and oscillator circuit

Notes: 1. The statuses of other registers and flags after MCU reset are shown in the following table.

2. X indicates invalid value. - indicates that the bit does not exist

Item	Abbr.		atus After ncellation of Stop ode by MCU Reset	Status After all Other Types of Reset
Carry flag	(CA)	Pre-stop-mode values are no values must be initialized by	Pre-MCU-reset values are not guaranteed; values must be initialized by program	
Accumulator	(A)			
B register	(B)			
W register	(W)	· 10		
X/SPX register	(X/SPX)			
Y/SPY register	(Y/SPY)	10		
Serial data register	(SRL, SRU)			_
RAM		Pre-stop-mode values are re	etained	
RAM enable flag	(RAME)	1 0		0
Port mode register 1 bit 2	(PMRC12)	Pre-stop-mode values 0 are retained	Cx	0

Interrupts

The MCU has 6 interrupt sources: Two external signals (\overline{INT}_0 , \overline{INT}_1), Three timer/counters (timers A, C, and D), and one serial interface (serial 1).

An interrupt request flag (IF), interrupt mask (IM), and vector address are provided for each interrupt source, and an interrupt enable flag (IE) controls the entire interrupt process.

Interrupt Control Bits and Interrupt Processing: Locations \$000 to \$003 and \$020 to \$021 in RAM are reserved for the interrupt control bits which can be accessed by RAM bit manipulation instructions.

The interrupt request flag (IF) cannot be set by software. MCU reset initializes the interrupt enable flag (IE) and the IF to 0 and the interrupt mask (IM) to 1.

A block diagram of the interrupt control circuit is shown in figure 8, interrupt priorities and vector addresses are listed in table 2, and interrupt processing conditions for the 6 interrupt sources are listed in table 3.

An interrupt request occurs when the IF is set to 1 and the IM is set to 0. If the IE is 1 at that point, the interrupt is processed. A priority programmable logic array (PLA) generates the vector address assigned to that interrupt source.

The interrupt processing sequence is shown in figure 9 and an interrupt processing flowchart is shown in figure 10. After an interrupt is acknowledged, the previous instruction is completed in the first cycle. The IE is reset in the second cycle, the carry, status, and program counter values are pushed onto the stack during the second and third cycles, and the program jumps to the vector address to execute the instruction in the third cycle.

Program the JMPL instruction at each vector address, to branch the program to the start address of the interrupt program, and reset the IF by a software instruction within the interrupt program.

Table 2 Vector Addresses and Interrupt Priorities

Reset/Interrupt	Priority	Vector Address
RESET, STOPC*	_	\$0000
ĪNT ₀	1	\$0002
ĪNT ₁	2	\$0004
Timer A	3	\$0006
Not used	4	\$0008
Timer C	5	\$000A
Timer D	6	\$000C
Serial 1	7	\$000E

Note: *The STOPC interrupt request is valid only in stop mode.

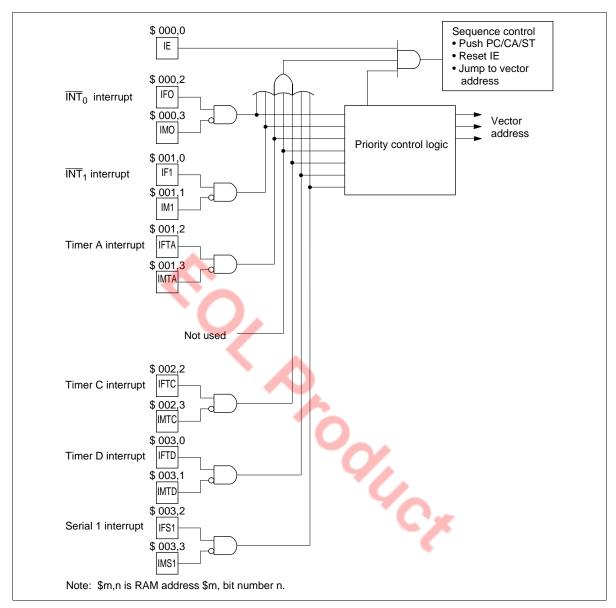


Figure 8 Interrupt Control Circuit

Table 3 Interrupt Processing and Activation Conditions

Interrupt Source

Interrupt Control Bit	ĪNT₀	ĪNT ₁	Timer A	Timer C	Timer D	Serial 1
IE	1	1	1	1	1	1
IF0 · ĪMO	1	0	0	0	0	0
IF1 · ĪM1	*	1	0	0	0	0
IFTA · ĪMTA	*	*	1	0	0	0
IFTC · ĪMTC	*	*	*	1	0	0
IFTD · IMTD	*	*	*	*	1	0
IFS1 · ĪMS1	*	*	*	*	*	1

Note: *Can be either 0 or 1. Their values have no effect on operation.

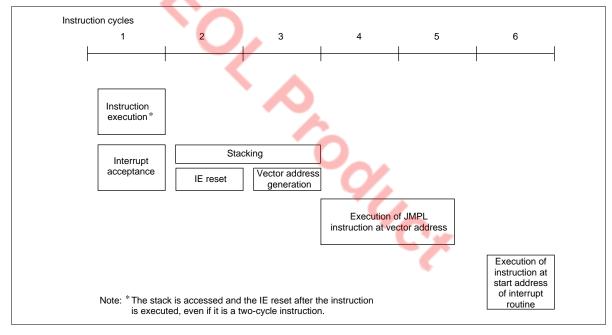


Figure 9 Interrupt Processing Sequence

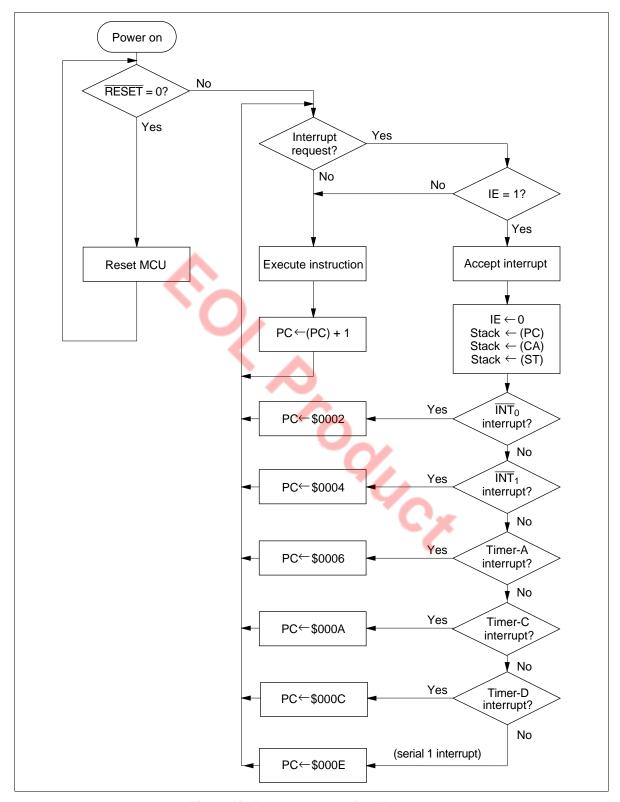


Figure 10 Interrupt Processing Flowchart

Interrupt Enable Flag (IE: \$000, Bit 0): Controls the entire interrupt process. It is reset by the interrupt processing and set by the RTNI instruction, as listed in table 4.

Table 4 Interrupt Enable Flag (IE: \$000, Bit 0)

IE	Interrupt Enabled/Disabled			
0	Disabled			
1	Enabled			

External Interrupts (\overline{INT}_0 , \overline{INT}_1): Two external interrupt signals.

External Interrupt Request Flags (IF0, IF1: \$000, \$001): IF0 and IF1 are set the falling of signals input to $\overline{\text{INT}}_0$ and $\overline{\text{INT}}_1$ as listed in table 5.

Table 5 External Interrupt Request Flags (IF0, IF1: \$000, \$001)

IF0, IF1	Interrupt Request	
0	No	
1	Yes	

External Interrupt Masks (IM0, IM1: \$000, \$001): Prevent (mask) interrupt requests caused by the corresponding external interrupt request flags, as listed in table 6.

Table 6 ExternalInterrupt Masks (IM0, 1M1: \$000, \$001)

IMO, IM1	Interrupt Request	4 1.
0	Enabled	9,
1	Disabled (masked)	10-

Timer A Interrupt Request Flag (IFTA: \$001, Bit 2): Set by overflow output from timer A, as listed in table 7.

Table 7 Timer A Interrupt Request Flag (IFTA: \$001, Bit 2)

IFTA	Interrupt Request
0	No
1	Yes

Timer A Interrupt Mask (IMTA: \$001, Bit 3): Prevents (masks) an interrupt request caused by the timer A interrupt request flag, as listed in table 8.

Table 8 Timer A Interrupt Mask (IMTA: \$001, Bit 3)

IMTA	Interrupt Request
0	Enabled
1	Disabled (masked)

Timer C Interrupt Request Flag (IFTC: \$002, Bit 2): Set by overflow output from timer C, as listed in table 9.

Table 9 Timer C Interrupt Request Flag (IFTC: \$002, Bit 2)

IFTC	Interrupt Request
0	No
1	Yes

Timer C Interrupt Mask (IMTC: \$002, Bit 3): Prevents (masks) an interrupt request caused by the timer C interrupt request flag, as listed in table 10.

Table 10 Timer C Interrupt Mask (IMTC: \$002, Bit 3)

IMTC	Interrupt Request	
0	Enabled	0,
1	Disabled (masked)	10

Timer D Interrupt Request Flag (IFTD: \$003, Bit 0): Set by overflow output from timer D, or by the rising or falling edge of signals input to EVND when the input capture function is used, as listed in table 11.

Table 11 Timer D Interrupt Request Flag (IFTD: \$003, Bit 0)

IFTD	Interrupt Request
0	No
1	Yes

Timer D Interrupt Mask (IMTD: \$003, Bit 1): Prevents (masks) an interrupt request caused by the timer D interrupt request flag, as listed in table 12.

Table 12 Timer D Interrupt Mask (IMTD: \$003, Bit 1)

IMTD	Interrupt Request
0	Enabled
1	Disabled (masked)

Serial Interrupt Request Flags (IFS1: \$003, Bit 2): Set when data transfer is completed or when data transfer is suspended, as listed in table 13.

Table 13 Serial Interrupt Request Flag (IFS1: \$003, Bit 2)

IFS1	Interrupt Request
0	No
1	Yes

Serial Interrupt Masks (IMS1: \$003, Bit 3): Prevents (masks) an interrupt request caused by the serial interrupt request flag, as listed in table 14.

Table 14 Serial Interrupt Mask (IMS1: \$003, Bit 3)

IMS1	Interrupt Request	
0	Enabled	0%
1	Disabled (masked)	40

Operating Modes

The MCU has Three operating modes as shown in table 15. The operations in each mode are listed in tables 16 and 17. Transitions between operating modes are shown in figure 11.

Table 15 Operating Modes and Clock Status

Mode Name

		Active	Standby	Stop
Activation method		RESET cancellation, interrupt request, STOPC cancellation in stop mode	SBY instruction	STOP instruction
Status	System oscillator	OP	OP	Stopped
Cancellation method		RESET input, STOP/SBY instruction	RESET input, interrupt request	RESET input, STOPC input in stop mode

Note: OP implies in operation

 Table 16
 Operations in Low-Power Dissipation Modes

Function	Stop Mode	Standby Mode
CPU	Reset	Retained
RAM	Retained	Retained
Timer A	Reset	OP
Timer C	Reset	OP
Timer D	Reset	OP
Serial interface 1	Reset	OP
Comparator	Reset	Stopped
I/O	Reset*	Retained

Note: OP implies in operation

Table 17 I/O Status in Low-Power Dissipation Modes

	Output		Input	
	Standby Mode	Stop Mode	Active Mode	
D ₀ –D ₉	Retained	High impedance	Input enabled	
D ₁₂ , D ₁₃ , RC ₀ ,	_	_	Input enabled	
RD_0-RD_3 , RE_0				
R0-R4	Retained or output of peripheral functions	High impedance	Input enabled	

^{*} Output pins are at high impedance.

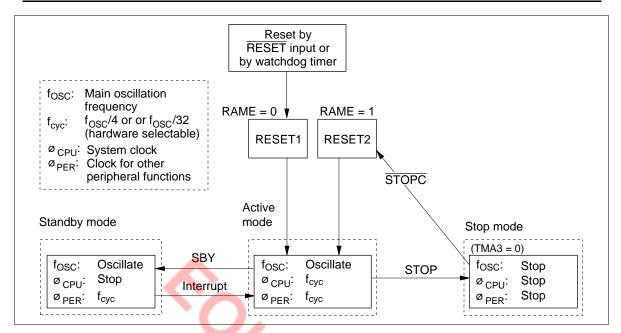


Figure 11 MCU Status Transitions

Active Mode: All MCU functions operate according to the clock generated by the system oscillators OSC_1 and OSC_2 .

Standby Mode: In standby mode, the oscillators continue to operate, but the clocks related to instruction execution stop. Therefore, the CPU operation stops, but all RAM and register contents are retained, and the D or R port status, when set to output, is maintained. Peripheral functions such as interrupts, timers, and serial interface continue to operate. The power dissipation in this mode is lower than in active mode because the CPU stops.

The MCU enters standby mode when the SBY instruction is executed in active mode.

Standby mode is terminated by a \overline{RESET} input or an interrupt request. If it is terminated by \overline{RESET} input, the MCU is reset as well. After an interrupt request, the MCU enters active mode and executes the next instruction after the SBY instruction. If the interrupt enable flag is 1, the interrupt is then processed; if it is 0, the interrupt request is left pending and normal instruction execution continues. A flowchart of operation in standby mode is shown in figure 12.

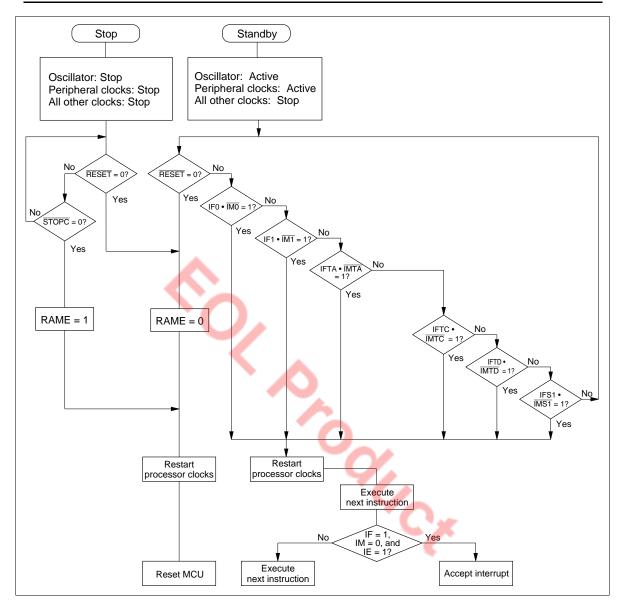


Figure 12 MCU Operation Flowchart

Stop Mode: In stop mode, all MCU operations stop and RAM data is retained. Therefore, the power dissipation in this mode is the least of all modes. The OSC₁ and OSC₂ oscillator stops. The MCU enters stop mode if the STOP instruction is executed in active mode.

Stop mode is terminated by a \overline{RESET} input or a \overline{STOPC} input as shown in figure 13. \overline{RESET} or \overline{STOPC} must be applied for at least one t_{RC} to stabilize oscillation (refer to the AC Characteristics section). When the MCU restarts after stop mode is cancelled, all RAM contents before entering stop mode are retained, but the accuracy of the contents of the accumulator, B register, W register, X/SPX register, Y/SPY register, carry flag, and serial data register cannot be guaranteed.

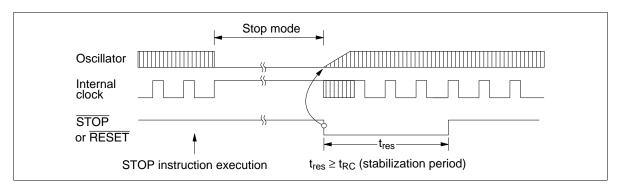


Figure 13 Timing of Stop Mode Cancellation

Stop Mode Cancellation by STOPC: The MCU enters active mode from stop mode by inputting STOPC as well as by \overline{RESET} . In either case, the MCU starts instruction execution from the starting address (address 0) of the program. However, the value of the RAM enable flag (RAME: \$021, bit 3) differs between cancellation by \overline{STOPC} and by \overline{RESET} . When stop mode is cancelled by \overline{RESET} , RAME = 0; when cancelled by \overline{STOPC} , RAME = 1. \overline{RESET} can cancel all modes, but \overline{STOPC} is valid only in stop mode; \overline{STOPC} input is ignored in other modes. Therefore, when the program requires to confirm that stop mode has been cancelled by \overline{STOPC} (for example, when the RAM contents before entering stop mode is used after transition to active mode), execute the TEST instruction to the RAM enable flag (RAME) at the beginning of the program.

MCU Operation Sequence: The MCU operates in the sequences shown in figures 14 to 16. It is reset by an asynchronous RESET input, regardless of its status.

The low-power mode operation sequence is shown in figure 16. With the IE flag cleared and an interrupt flag set together with its interrupt mask cleared, if a STOP/SBY instruction is executed, the instruction is cancelled (regarded as an NOP) and the following instruction is executed. Before executing a STOP/SBY instruction, make sure all interrupt flags are cleared or all interrupts are masked.

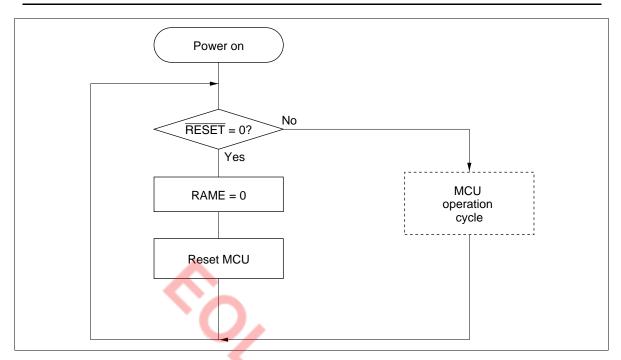


Figure 14 MCU Operating Sequence (Power On)

SOOK CX

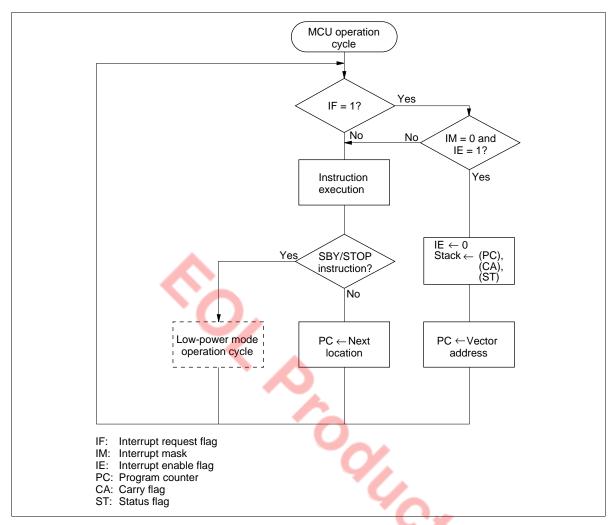


Figure 15 MCU Operating Sequence (MCU Operation Cycle)

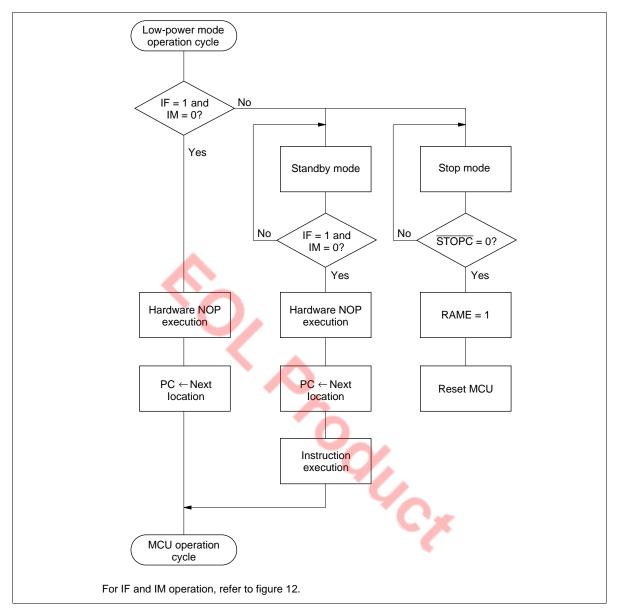


Figure 16 MCU Operating Sequence (Low-Power Mode Operation)

Internal Oscillator Circuit

A block diagram of the clock generation circuit is shown in figure 17. As shown in table 18, a ceramic oscillator can be connected to OSC_1 and OSC_2 . The system oscillator can also be operated by an external clock.

After RESET input or after stop mode has been cancelled, the division ratio of the system clock can be selected as 1/4 or 1/32 by setting the SEL pin level.

- 1/4 division ratio: Connect SEL to V_{CC}.
- 1/32 division ratio: Connect SEL to GND.

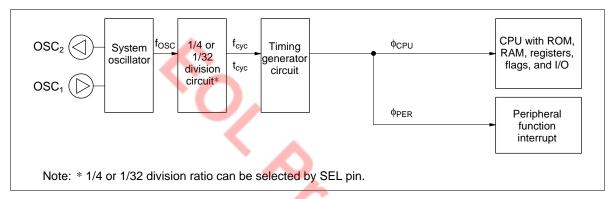


Figure 17 Clock Generation Circuit

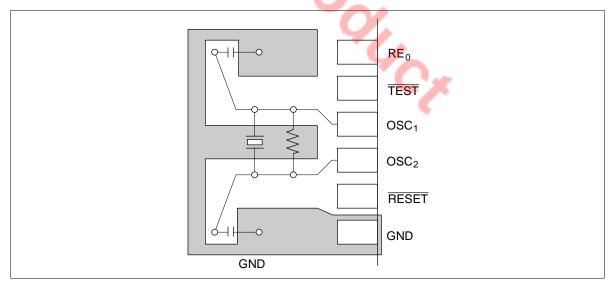


Figure 18 Typical Layout of Ceramic Oscillator

Table 18 Oscillator Circuit Examples

Circuit Configuration Circuit Constants External clock External OSC₁ operation oscillator Open OSC₂ Ceramic oscillator Ceramic oscillator: CSB400P22 (Murata), C_1 (OSC₁, OSC₂) CSB400P (Murata) OSC₁ Ceramic $R_f = 1 M\Omega \pm 20\%$ R_f≨ oscillator $C_1 = C_2 = 220 \text{ pF} \pm 5\%$ OSC₂ **GND** Ceramic oscillator: CSB800J122 (Murata), CSB800J (Murata) $R_f = 1 M\Omega \pm 20\%$ $C_1 = C_2 = 220 \text{ pF} \pm 5\%$ Ceramic oscillator: CSA2.00MG (Murata) R_f = 1 $M\Omega \pm 20\%$ $C_1 = C_2 = 30 \text{ pF} \pm 20\%$ Ceramic oscillator: CSA4.00MG (Murata) $R_f = 1 M\Omega \pm 20\%$ $C_1 = C_2 = 30 \text{ pF} \pm 20\%$ Ceramic oscillator: CSA3.58MG (Murata) $R_f = 1 M\Omega \pm 20\%$ $C_1 = C_2 = 30 \text{ pF} \pm 20\%$

- Notes: 1. Since the circuit constants change depending on the ceramic oscillator and stray capacitance of the board, the user should consult with the ceramic oscillator manufacturer to determine the circuit parameters.
 - 2. Wiring among OSC₁, OSC₂, and elements should be as short as possible, and must not cross other wiring (see figure 18).

Input/Output

The MCU has 27 input/output pins (D_0 – D_9 , $R0_0$ – $R4_3$) and 8 input pins (D_{12} , D_{13} , RC_0 , RD_0 – RD_3 , RE_0). The features are described below. Some input/output pins have different features between the HD404054 Series and HD404094 Series. The differences between the HD404054 Series and HD404094 Series are listed in table 19.

- A maximum current of 15 mA is allowed for each of the pins D₄ to D₉ with a total maximum current of less than 105 mA. In addition, D₀–D₃ can each act as a 10-mA maximum current source.
- Some input/output pins are multiplexed with peripheral function pins such as for the timers or serial interface. For these pins, the peripheral function setting is done prior to the D or R port setting. Therefore, when a peripheral function is selected for a pin, the pin function and input/output selection are automatically switched according to the setting.
- Input or output selection for input/output pins and port or peripheral function selection for multiplexed pins are set by software.
- Peripheral function output pins are CMOS output pins. Only the R4₃/SO₁ pin can be set to NMOS opendrain output by software.
- In stop mode, the MCU is reset, and therefore peripheral function selection is cancelled. Input/output pins are in high-impedance state.
- Pins D₀–D₃ have built-in pull-down MOSs, and other input/output pins have built-in pull-up MOSs, which can be individually turned on or off by software.

I/O buffer configuration is shown in figure 19 programmable I/O circuits are listed in table 20, and I/O pin circuit types are shown in table 21.

Table 19 The differences between HD404054 Series and HD404094 Series

	HD404054 Series	HD404094 Series
Large-current source pins (15 mA)	D ₀ -D ₃	D ₀ -D ₃
Large-current sink pins (10 mA)	D ₄ –D ₉	D ₈ , D ₉
Intermediate voltage NMOS open-drain pins (12 V)	_	D ₄ –D ₇ (output only)
Pull-down MOS current pins	D ₀ -D ₃	D ₀ -D ₃
Pull-up MOS current pins	D ₄ –D ₉ , R0–R4	D ₈ , D ₉ , R0–R4

Table 20-1 Programmable I/O Circuits (with pull-up MOS)

MIS3 (Bit 3 of	MIS)	0			1				
DCD, DCR		0		1		0		1	
PDR		0	1	0	1	0	1	0	1
CMOS buffer	PMOS	_	_	_	On	_	_	_	On
	NMOS	_	_	On	_	_	_	On	_
Pull-up MOS		_	_	_	_	_	On	_	On

Note: — indicates off status.

Table 20-2 Programmable I/O Circuits (with pull-down MOS)

MIS3 (Bit 3 of MIS)			0	1							
DCD, DCR		\wedge	0		1		0		1		
PDR			0	1	0	1	0	1	0	1	
014001 "											
CMOS buffer	PMOS	1			_	On	_	_	_	On	
CIMOS buffer	PMOS NMOS		9	_	On	On —			On	On —	

Note: — indicates off status.

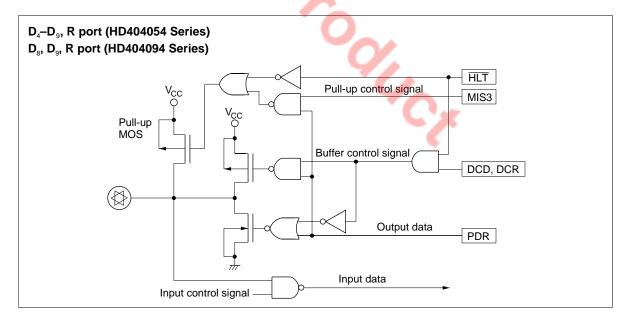


Figure 19-1 I/O Buffer Configuration (with pull-up MOS)

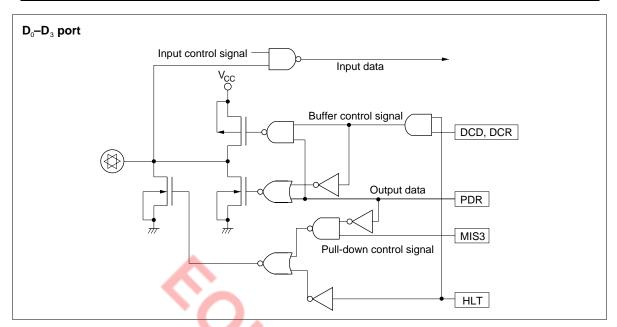
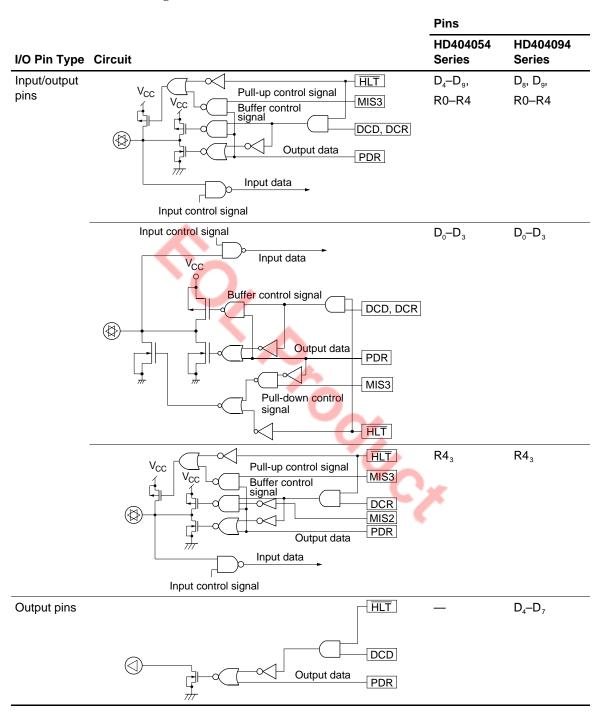
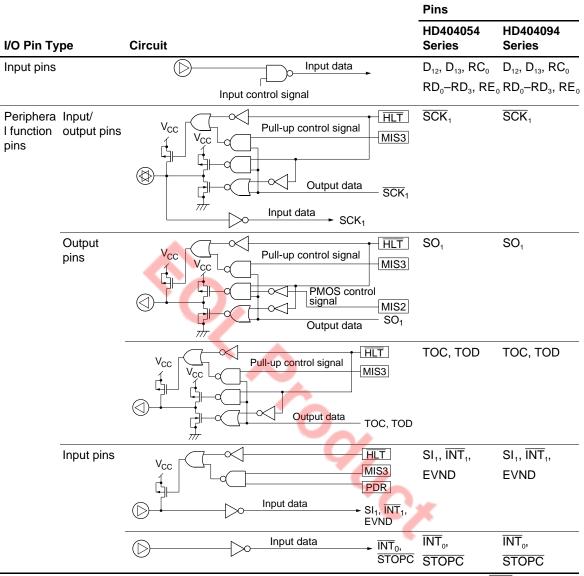


Figure 19-2 I/O Buffer Configuration (with pull-down MOS)

Table 21 Circuit Configurations of I/O Pins





Note: The MCU is reset in stop mode, and peripheral function selection is cancelled. The HLT signal becomes low, and input/output pins enter high-impedance state.

D Port (D_0 – D_{13}): Consist of 10 input/output pins and 2 input pins addressed by one bit. D_0 – D_3 are high-current sources, and D_{12} and D_{13} are input-only pins. D_4 – D_9 of the HD404054 Series are high-current sinks. D_4 – D_7 of the HD404094 Series are middle voltage output-only pins, and D_8 and D_9 are high-current sink pins.

Pins D_0 – D_9 are set by the SED and SEDD instructions, and reset by the RED and REDD instructions. Output data is stored in the port data register (PDR) for each pin. All pins D_0 – D_{13} are tested by the TD and TDD instructions.

The on/off statuses of the output buffers are controlled by D-port data control registers (DCD0–DCD2: \$02C–\$02E) that are mapped to memory addresses (figure 20).

Pins D_{12} and D_{13} are multiplexed with peripheral function pins \overline{STOPC} and $\overline{INT_0}$, respectively. The peripheral function modes of these pins are selected by bits 2 and 3 (PMRC2, PMRC3) of port mode register C (PMRC: \$025) (figure 22).

R Ports (**R0**₀–**RE**₀): 17 input/output pins and 6 input pins addressed in 4-bit units. Data is input to these ports by the LAR and LBR instructions, and output from them by the LRA and LRB instructions. *Output data is stored in the port data register (PDR) for each pin. The on/off statuses of the output buffers of the R ports are controlled by R-port data control registers (DCR0–DCR4: \$030–\$034) that are mapped to memory addresses (figure 20).

Pin R0₀ is are multiplexed with peripheral pin \overline{INT}_1 respectively. The peripheral function modes of these pins are selected by bit 0 (PMRB0) of port mode register B (PMRB: \$024) (figure 21).

Pins R3₁–R3₂ are multiplexed with peripheral pins TOC and TOD respectively. The peripheral function modes of these pins are selected by bits 0–2 (TMC20–TMC22) of timer mode register C2 (TMC2: \$014), and bits 0–3 (TMD20–TMD23) of timer mode register D2 (TMD2: \$015) (figures 23, and 24).

Pin R4₀ is multiplexed with peripheral pin EVND respectively. The peripheral function modes of these pins are selected by bit 1 (PMRC1) of port mode register C (PMRC: \$025) (figure 22).

Pins $R4_1$ – $R4_3$ are multiplexed with peripheral pins \overline{SCK}_1 , SI_1 , and SO_1 , respectively. The peripheral function modes of these pins are selected by bit 3 (SM1A3) of serial mode register 1A (SM1A: \$005), and bits 0 and 1 (PMRA0, PMRA1) of port mode register A (PMRA: \$004), as shown in figures 25 and 26.

Ports RD₀ and RD₁ are multiplexed with peripheral function pins COMP₀ and COMP₁, respectively. The function modes of these pins are selected by bit 3 (CER3) of the compare enable register (CER: \$018) (figure 27).

Port RE₀ is multiplexed with peripheral function pin VC_{ref} . While functioning as VC_{ref} , do not use this pin as an R port at the same time, otherwise, the MCU may malfunction.

Pull-Up or Pull-Down MOS Transistor Control: A program-controlled pull-up or pull-down MOS transistor is provided for each input/output pin other than input-only pins D₁₂ and D₁₃. The on/off status of all these transistors is controlled by bit 3 (MIS3) of the miscellaneous register (MIS: \$00C), and the on/off status of an individual transistor can also be controlled by the port data register (PDR) of the corresponding pin—enabling on/off control of that pin alone (table 20 and figure 28).

The on/off status of each transistor and the peripheral function mode of each pin can be set independently.

How to Deal with Unused I/O Pins: I/O pins that are not needed by the user system (floating) must be connected to V_{CC} to prevent LSI malfunctions due to noise. These pins must either be pulled up to V_{CC} by their pull-up MOS transistors or by resistors of about 100 kΩ or pulled down to GND by their pull-down MOS transistors.

Note: *If nonexisted bits of R ports is read, undifined data will be latched to accumulator (A) or the B register.

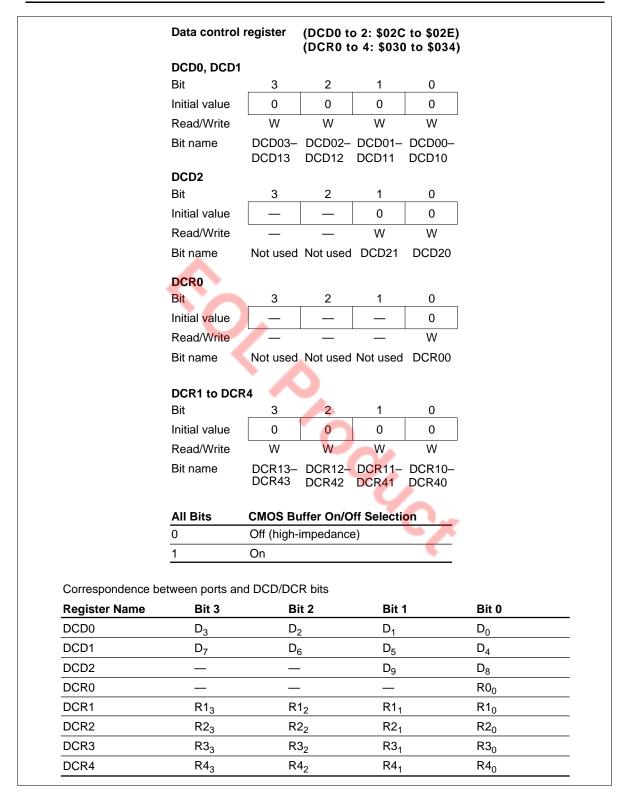


Figure 20 Data Control Registers (DCD, DCR)

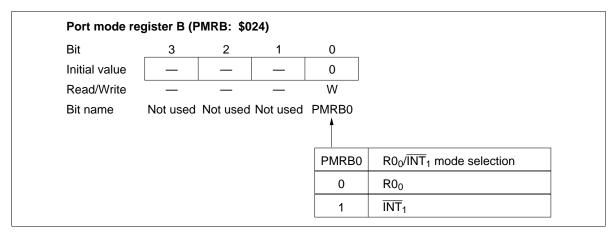


Figure 21 Port Mode Register B (PMRB)

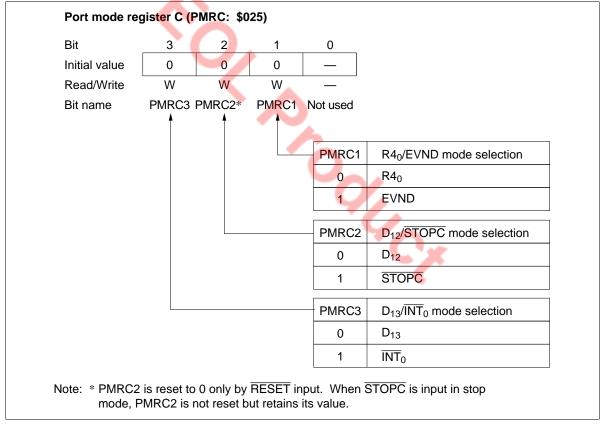


Figure 22 Port Mode Register C (PMRC)

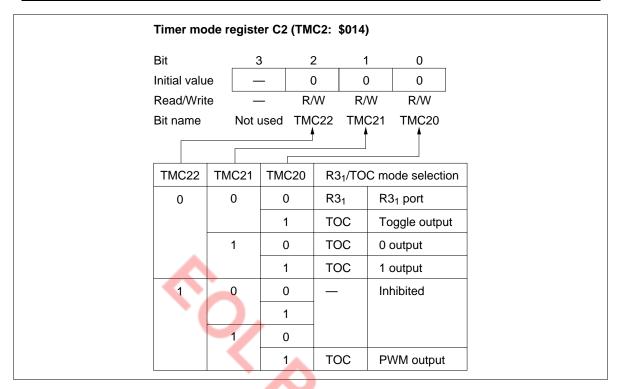


Figure 23 Timer Mode Register C2 (TMC2)

Odlick

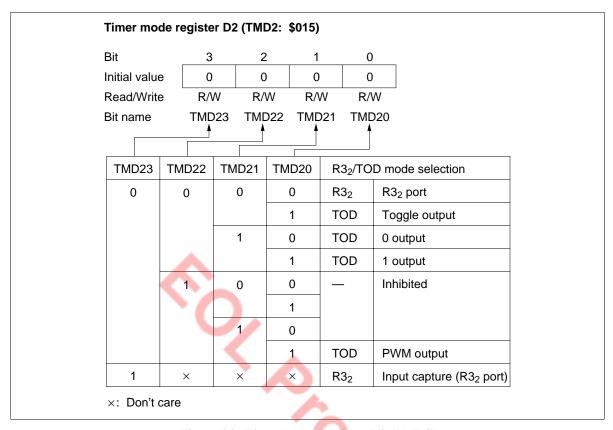


Figure 24 Timer Mode Register D2 (TMD2)

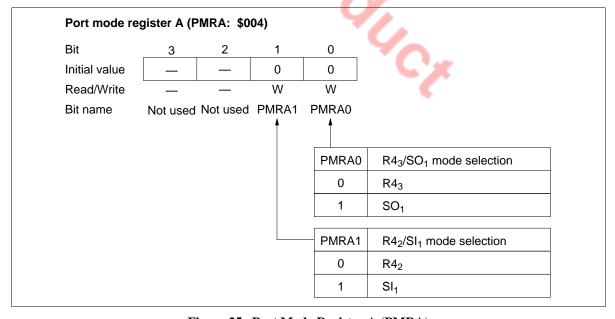


Figure 25 Port Mode Register A (PMRA)

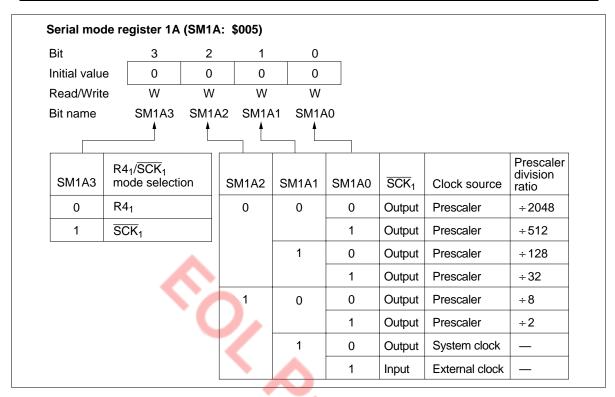


Figure 26 Serial Mode Register 1A (SM1A)

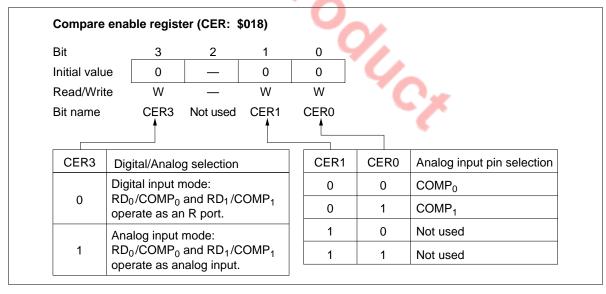


Figure 27 Compare Enable Register

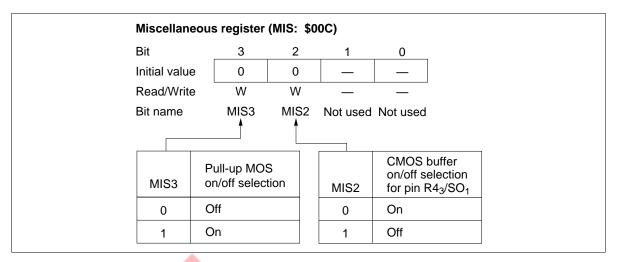


Figure 28 Miscellaneous Register (MIS)

Prescalers

The MCU has the following prescaler S.

The prescaler operating conditions are listed in table 22, and the prescaler output supply is shown in figure 29. The timers A, C, D input clocks except external events and the serial transmit clock except the external clock are selected from the prescaler outputs, depending on corresponding mode registers.

Prescaler Operation

Prescaler S: 11-bit counter that inputs a system clock signal. After being reset to \$000 by MCU reset, prescaler S divides the system clock. Prescaler S keeps counting, except at MCU reset.

Table 22 Prescaler Operating Conditions

Prescaler	Input Clock	Reset Condition	Stop Conditions
Prescaler S	System clock	MCU reset	MCU reset, stop mode

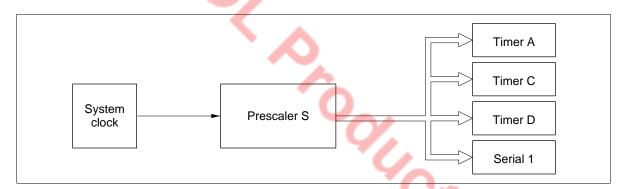


Figure 29 Prescaler Output Supply

Timers

The MCU has three timer/counters (A, C, and D).

- Timer A: Free-running timer
- Timer C: Multifunction timer
- Timer D: Multifunction timer

Timer A is an 8-bit free-running timer. Timers C and D are 8-bit multifunction timers, whose functions are listed in table 23. The operating modes are selected by software.

Timer A

Timer A Functions: Timer A has the following functions.

Free-running timer
 The block diagram of timer A is shown in figure 30.

Timer A Operations:

• Free-running timer operation: The input clock for timer A is selected by timer mode register A (TMA: \$008).

Timer A is reset to \$00 by MCU reset and incremented at each input clock. If an input clock is applied to timer A after it has reached \$FF, an overflow is generated, and timer A is reset to \$00. The overflow sets the timer A interrupt request flag (IFTA: \$001, bit 2). Timer A continues to be incremented after reset to \$00, and therefore it generates regular interrupts every 256 clocks.

Registers for Timer A Operation: Timer A operating modes are set by the following registers.

• Timer mode register A (TMA: \$008): Four-bit write-only register that selects timer A's operating mode and input clock source as shown in figure 31.

Table 23 Timer Functions

Functions		Timer A	Timer C	Timer D
Clock source	Prescaler S	Available	Available	Available
	External event	_	_	Available
Timer functions	Free-running	Available	Available	Available
	Event counter	_	_	Available
	Reload	_	Available	Available
	Watchdog	_	Available	_
	Input capture	_	_	Available
Timer outputs	Toggle	_	Available	Available
	0 output	_	Available	Available
	1 output	_	Available	Available
	PWM	_	Available	Available

Note: — means not available.

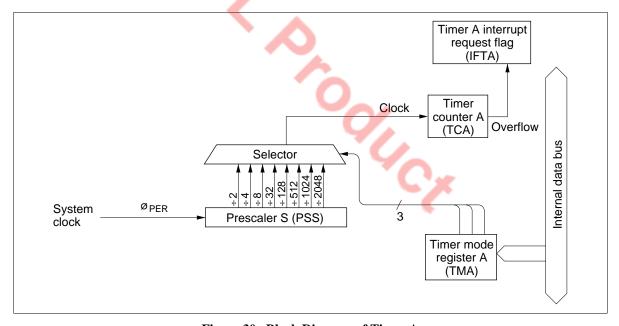


Figure 30 Block Diagram of Timer A

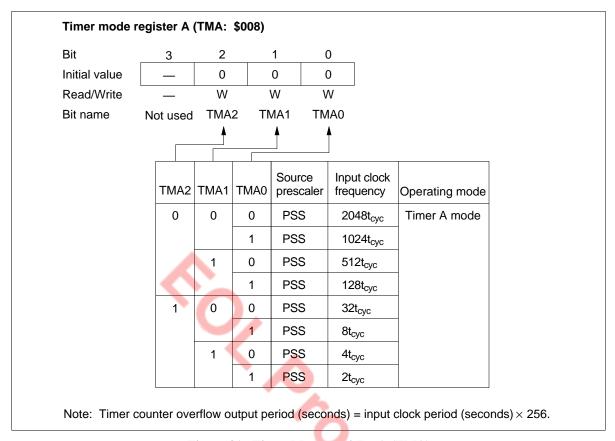


Figure 31 Timer Mode Register A (TMA)

Timer C

Timer C Functions: Timer C has the following functions.

- Free-running/reload timer
- Watchdog timer
- Timer output operation (toggle, 0, 1, and PWM outputs)

The block diagram of timer C is shown in figure 32.

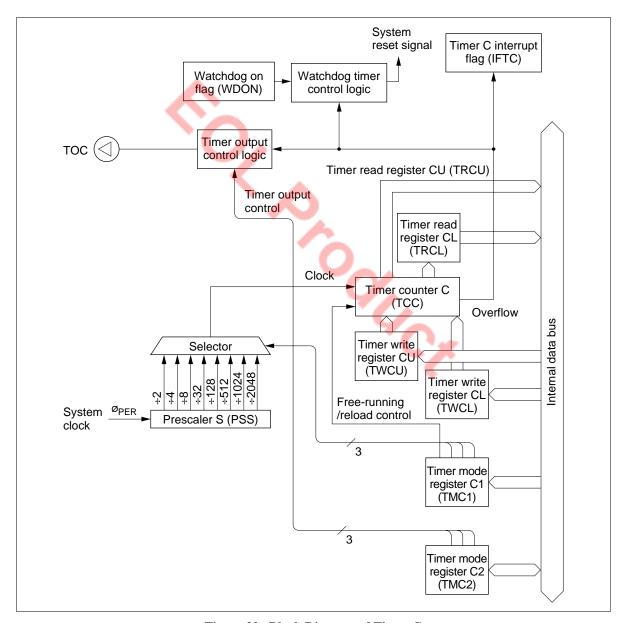


Figure 32 Block Diagram of Timer C

Timer C Operations:

• Free-running/reload timer operation: The free-running/reload operation, input clock source, and prescaler division ratio are selected by timer mode register C1 (TMC1: \$00D).

Timer C is initialized to the value set in timer write register C (TWCL: \$00E, TWCU: \$00F) by software and incremented by one at each clock input. If an input clock is applied to timer C after it has reached \$FF, an overflow is generated. In this case, if the reload timer function is enabled, timer C is initialized to its initial value set in timer write register C; if the free-running timer function is enabled, the timer is initialized to \$00 and then incremented again.

The overflow sets the timer C interrupt request flag (IFTC: \$002, bit 2). IFTC is reset by software or MCU reset. Refer to figure 3 and table 1 for details.

- Watchdog timer operation: Timer C is used as a watchdog timer for detecting out-of-control program routines by setting the watchdog on flag (WDON: \$020, bit 1) to 1. If a program routine runs out of control and an overflow is generated, the MCU is reset. Program run can be controlled by initializing timer C by software before it reaches \$FF.
- Timer output operation: The following four output modes can be selected for timer C by setting timer mode register C2 (TMC2: \$014).

Toggle

0 output

1 output

PWM output

By selecting the timer output mode, pin R3₁/TOC is set to TOC. The output from TOC is reset low by MCU reset

- Toggle output: When toggle output mode is selected, the output level is inverted if a clock is input after timer C has reached \$FF. By using this function and reload timer function, clock signals can be output at a required frequency for the buzzer. The output waveform is shown in figure 33.
- PWM output: When PWM output mode is selected, timer C provides the variable-duty pulse output function. The output waveform differs depending on the contents of timer mode register C1 (TMC1: \$00D) and timer write register C (TWCL: \$00E, TWCU: \$00F). The output waveform is shown in figure 33.
- 0 output: When 0 output mode is selected, the output level is pulled low if a clock is input after timer C has reached \$FF. Note that this function must be used only when the output level is high.
- 1 output: When 1 output mode is selected, the output level is set high if a clock is input after timer C has reached \$FF. Note that this function must be used only when the output level is low.

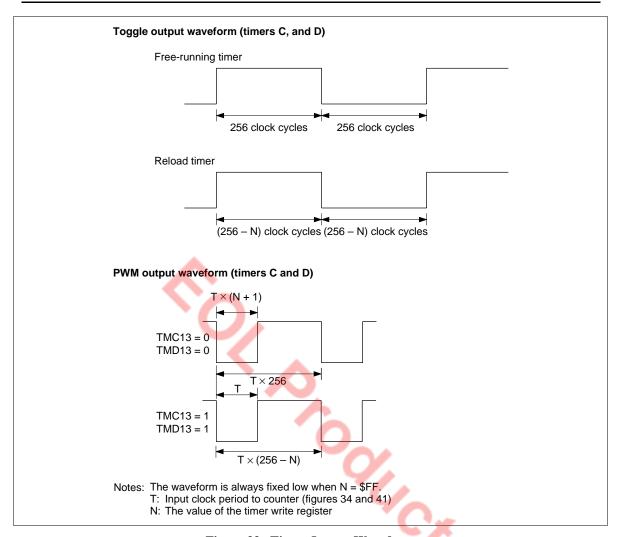


Figure 33 Timer Output Waveform

Registers for Timer C Operation: By using the following registers, timer C operation modes are selected and the timer C count is read and written.

Timer mode register C1 (TMC1: \$00D)

Timer mode register C2 (TMC2: \$014)

Timer write register C (TWCL: \$00E, TWCU: \$00F)

Timer read register C (TRCL: \$00E, TRCU: \$00F)

• Timer mode register C1 (TMC1: \$00D): Four-bit write-only register that selects the free-running/reload timer function, input clock source, and the prescaler division ratio as shown in figure 34. It is reset to \$0 by MCU reset.

Writing to this register is valid from the second instruction execution cycle after the execution of the previous timer mode register C1 write instruction. Setting timer C's initialization by writing to timer write register C (TWCL: \$00E, TWCU: \$00F) must be done after a mode change becomes valid.

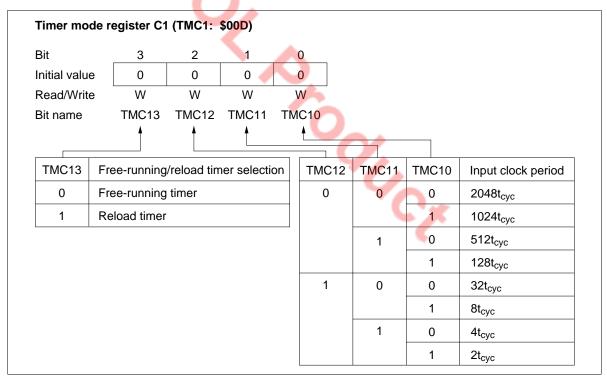


Figure 34 Timer Mode Register C1 (TMC1)

• Timer mode register C2 (TMC2: \$014): Three-bit read/write register that selects the timer C output mode as shown in figure 35. It is reset to \$0 by MCU reset.

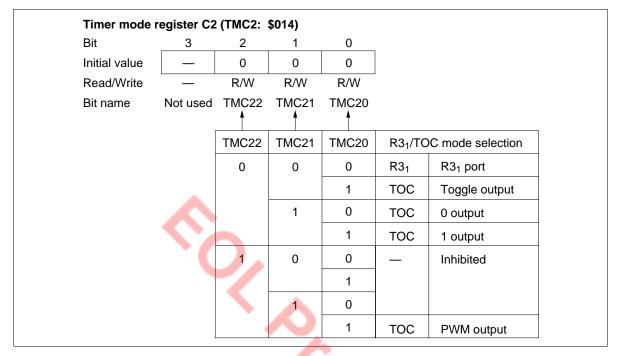


Figure 35 Timer Mode Register C2 (TMC2)

• Timer write register C (TWCL: \$00E, TWCU: \$00F): Write-only register consisting of a lower digit (TWCL) and an upper digit (TWCU) as shown in figures 36 and 37. The lower digit is reset to \$0 by MCU reset, but the upper digit value is invalid.

Timer C is initialized by writing to timer write register C (TWCL: \$00E, TWCU: \$00F). In this case, the lower digit (TWCL) must be written to first, but writing only to the lower digit does not change the timer C value. Timer C is initialized to the value in timer write register C at the same time the upper digit (TWCU) is written to. When timer write register C is written to again and if the lower digit value needs no change, writing only to the upper digit initializes timer C.

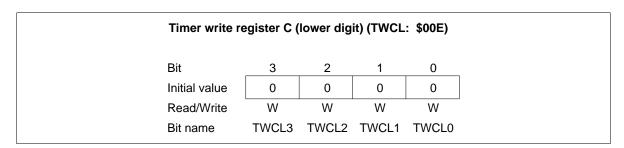


Figure 36 Timer Write Register C Lower Digit (TWCL)

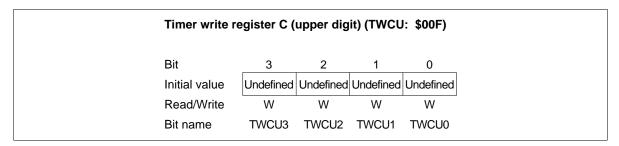


Figure 37 Timer Write Register C Upper Digit (TWCU)

• Timer read register C (TRCL: \$00E, TRCU: \$00F): Read-only register consisting of a lower digit (TRCL) and an upper digit (TRCU) that holds the count of the timer C upper digit as shown in figures 38 and 39. The upper digit (TRCU) must be read first. At this time, the count of the timer C upper digit is obtained, and the count of the timer C lower digit is latched to the lower digit (TRCL). After this, by reading TRCL, the count of timer C when TRCU is read can be obtained.

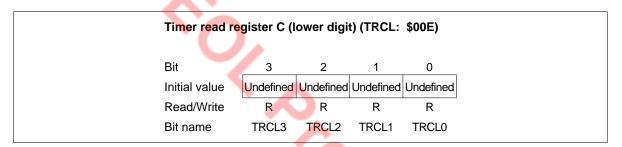


Figure 38 Timer Read Register C Lower Digit (TRCL)

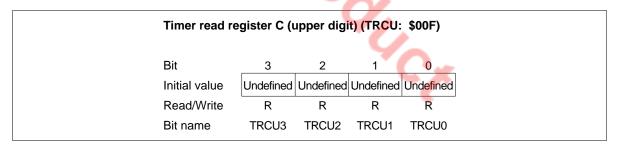


Figure 39 Timer Read Register C Upper Digit (TRCU)

Timer D

Timer D Functions: Timer D has the following functions.

- Free-running/reload timer
- External event counter
- Timer output operation (toggle, 0, 1, and PWM outputs)
- Input capture timer

The block diagram for each operation mode of timer D is shown in figures 40-1 and 40-2.

Timer D Operations:

- Free-running/reload timer operation: The free-running/reload operation, input clock source, and prescaler division ratio are selected by timer mode register D1 (TMD1: \$010).
 - Timer D is initialized to the value set in timer write register D (TWDL: \$011, TWDU: \$012) by software and incremented by one at each clock input. If an input clock is applied to timer D after it has reached \$FF, an overflow is generated. In this case, if the reload timer function is enabled, timer D is initialized to its initial value set in timer write register D; if the free-running timer function is enabled, the timer is initialized to \$00 and then incremented again.
 - The overflow sets the timer D interrupt request flag (IFTD: \$003, bit 0). IFTD is reset by software or MCU reset. Refer to figure 3 and table 1 for details.
- External event counter operation: Timer D is used as an external event counter by selecting the external event input as an input clock source. In this case, pin R4₀/EVND must be set to EVND by port mode register C (PMRC: \$025).
 - Either falling or rising edge, or both falling and rising edges of input signals can be selected as the external event detection edge by detection edge select register 2 (ESR2: \$027). When both rising and falling edges detection is selected, the time between the falling edge and rising edge of input signals must be $2t_{\rm evc}$ or longer.
 - Timer D is incremented by one at each detection edge selected by detection edge select register 2 (ESR2: \$027). The other operation is basically the same as the free-running/reload timer operation.
- Timer output operation: The following four output modes can be selected for timer D by setting timer mode register D2 (TMD2: \$015).

Toggle

0 output

1 output

PWM output

By selecting the timer output mode, pin R3₂/TOD is set to TOD. The output from TOD is reset low by MCU reset.

- Toggle output: The operation is basically the same as that of timer-C's toggle output.
- 0 output: The operation is basically the same as that of timer-C's 0 output.
- 1 output: The operation is basically the same as that of timer-C's 1 output.

- PWM output: The operation is basically the same as that of timer-C's PWM output.
- Input capture timer operation: The input capture timer counts the clock cycles between trigger edges input to pin EVND.

Either falling or rising edge, or both falling and rising edges of input signals can be selected as the trigger input edge by detection edge select register 2 (ESR2: \$027).

When a trigger edge is input to EVND, the count of timer D is written to timer read register D (TRDL: \$011, TRDU: \$012), and the timer D interrupt request flag (IFTD: \$003, bit 0) and the input capture status flag (ICSF: \$021, bit 0) are set. Timer D is reset to \$00, and then incremented again. While ICSF is set, if a trigger input edge is applied to timer D, or if timer D generates an overflow, the input capture error flag (ICEF: \$021, bit 1) is set. ICSF and ICEF are reset to 0 by MCU reset or by writing 0.

By selecting the input capture operation, pin R3₂/TOD is set to R3₂ and timer D is reset to \$00.



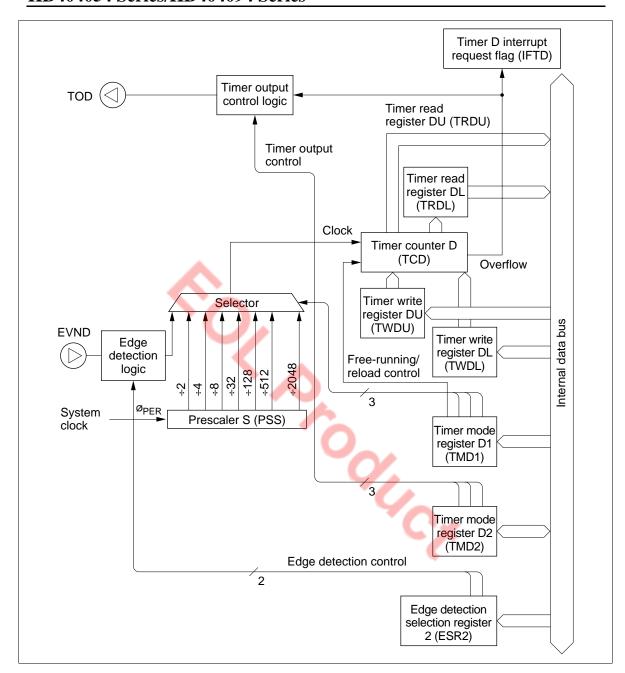


Figure 40-1 Block Diagram of Timer D (Free-Running/Reload Timer)

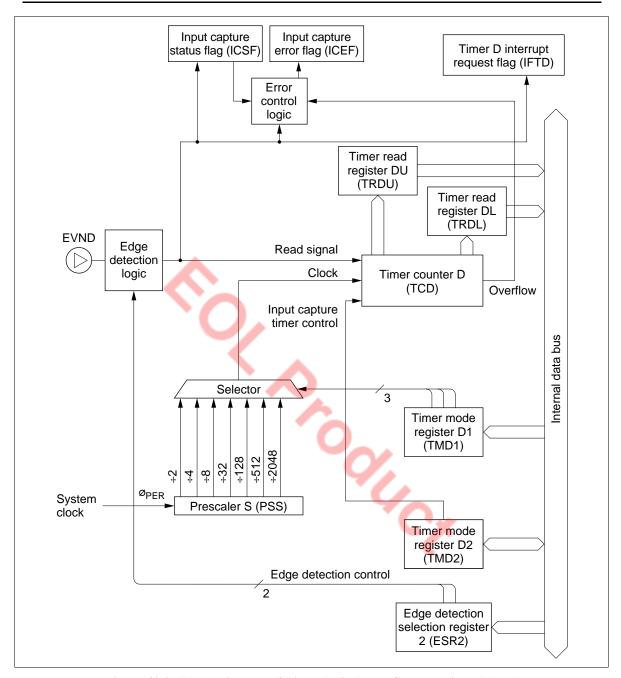


Figure 40-2 Block Diagram of Timer D (in Input Capture Timer Mode)

Registers for Timer D Operation: By using the following registers, timer D operation modes are selected and the timer D count is read and written.

Timer mode register D1 (TMD1: \$010)

Timer mode register D2 (TMD2: \$015)

Timer write register D (TWDL: \$011, TWDU: \$012)

Timer read register D (TRDL: \$011, TRDU: \$012)

Port mode register C (PMRC: \$025)

Detection edge select register 2 (ESR2: \$027)

• Timer mode register D1 (TMD1: \$010): Four-bit write-only register that selects the free-running/reload timer function, input clock source, and the prescaler division ratio as shown in figure 41. It is reset to \$0 by MCU reset.

Writing to this register is valid from the second instruction execution cycle after the execution of the previous timer mode register D1 (TMD1: \$010) write instruction. Setting timer D's initialization by writing to timer write register D (TWDL: \$011, TWDU: \$012) must be done after a mode change becomes valid.

When selecting the input capture timer operation, select the internal clock as the input clock source.

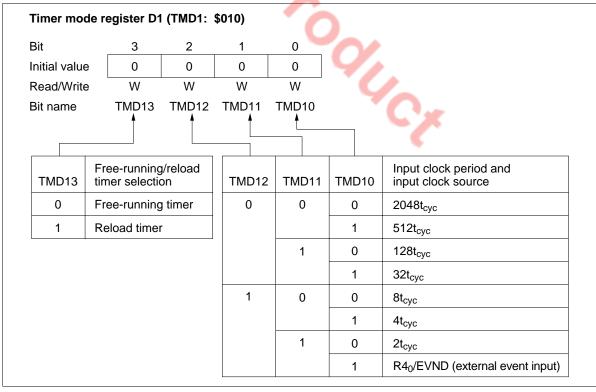


Figure 41 Timer Mode Register D1 (TMD1)

• Timer mode register D2 (TMD2: \$015): Four-bit read/write register that selects the timer D output mode and input capture operation as shown in figure 42. It is reset to \$0 by MCU reset.

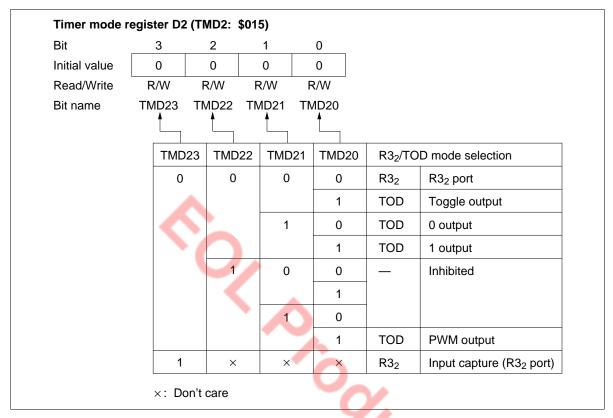


Figure 42 Timer Mode Register D2 (TMD2)

• Timer write register D (TWDL: \$011, TWDU: \$012): Write-only register consisting of a lower digit (TWDL) and an upper digit (TWDU) as shown in figures 43 and 44. The operation of timer write register D is basically the same as that of timer write register C (TWCL: \$00E, TWCU: \$00F).

Tir	Timer write register D (lower digit) (TWDL: \$011)				\$011)
Bit	t _	3	2	1	0
Init	tial value	0	0	0	0
Re	ead/Write	W	W	W	W
Bit	t name	TWDL3	TWDL2	TWDL1	TWDL0

Figure 43 Timer Write Register D Lower Digit (TWDL)

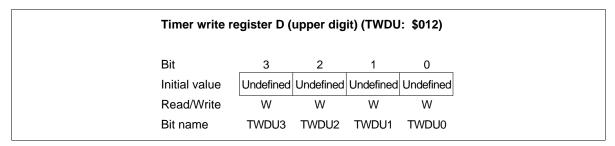


Figure 44 Timer Write Register D Upper Digit (TWDU)

• Timer read register D (TRDL: \$011, TRDU: \$012): Read-only register consisting of a lower digit (TRDL) and an upper digit (TRDU) as shown in figures 45 and 46. The operation of timer read register D is basically the same as that of timer read register C (TRCL: \$00E, TRCU: \$00F).

When the input capture timer operation is selected and if the count of timer D is read after a trigger is input, either the lower or upper digit can be read first.

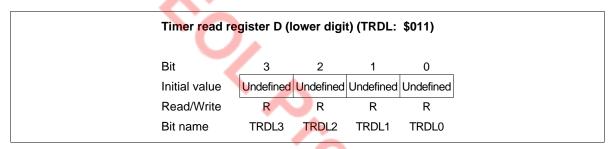


Figure 45 Timer Read Register D Lower Digit (TRDL)

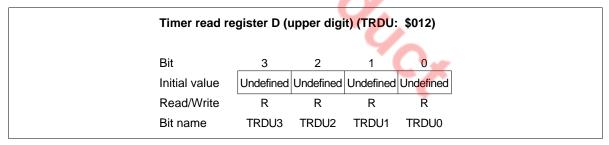


Figure 46 Timer Read Register D Upper Digit (TRDU)

• Port mode register C (PMRC: \$025): Write-only register that selects R4₀/EVND pin function as shown in figure 47. It is reset to \$0 by MCU reset.

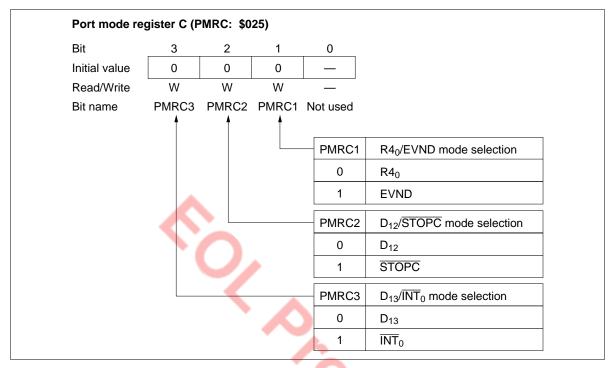


Figure 47 Port Mode Register C (PMRC)

• Detection edge select register 2 (ESR2: \$027): Write-only register that selects the detection edge of signals input to pin EVND as shown in figure 48. It is reset to \$0 by MCU reset.

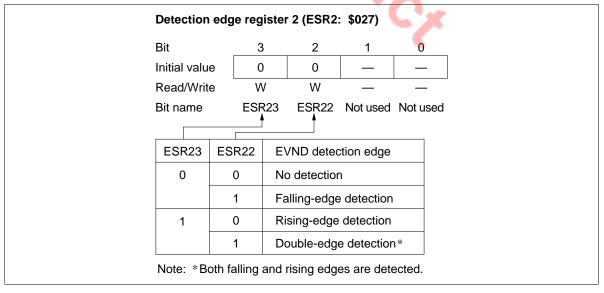
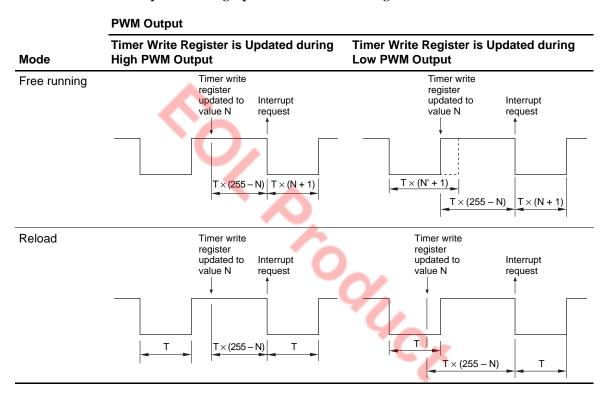


Figure 48 Detection Edge Select Register 2 (ESR2)

Notes on Use

When using the timer output as PWM output, note the following point. From the update of the timer write register until the occurrence of the overflow interrupt, the PWM output differs from the period and duty settings, as shown in table 24. The PWM output should therefore not be used until after the overflow interrupt following the update of the timer write register. After the overflow, the PWM output will have the set period and duty cycle.

Table 24 PWM Output Following Update of Timer Write Register



Serial Interface 1

The MCU has one channel of serial interface. The serial interface serially transfers or receives 8-bit data, and includes the following features.

Odlick

- Multiple transmit clock sources
 - External clock
 - Internal prescaler output clock
 - System clock
- Output level control in idle states

Serial interface 1

- Serial data register 1 (SR1L: \$006, SR1U: \$007)
- Serial mode register 1A (SM1A: \$005)
- Serial mode register 1B (SM1B: \$028)
- Port mode register A (PMRA: \$004)
- Miscellaneous register (MIS: \$00C)
- Octal counter (OC)
- Selector

The block diagram of serial interface 1 is shown in figure 49.

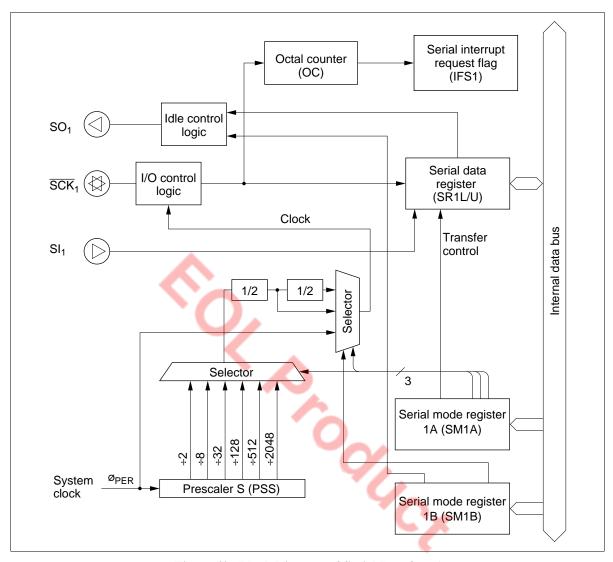


Figure 49 Block Diagram of Serial Interface 1

Serial Interface Operation

Selecting and Changing the Operating Mode: Table 25 lists the serial interface's operating modes. To select an operating mode, use one of these combinations of port mode register A (PMRA: \$004), and serial mode register 1A (SM1A: \$005) settings; to change the operating mode of serial interface 1, always initialize the serial interface internally by writing data to serial mode register 1A. Note that serial interface 1 is initialized by writing data to serial mode register 1A. Refer to the following section Registers for Serial Interface for details.

Pin Setting: The R4₁/ \overline{SCK}_1 pin is controlled by writing data to serial mode register 1A (SM1A: \$005). Pins R4₂/SI₁ and R4₃/SO₁ are controlled by writing data to port mode register A (PMRA: \$004). Refer to the following section Registers for Serial Interface for details.

Transmit Clock Source Setting: The transmit clock source of serial interface 1 is set by writing data to serial mode register 1A (SM1A: \$005) and serial mode register 1B (SM1B: \$028). Refer to the following section Registers for Serial Interface for details.

Data Setting: Transmit data of serial interface 1 is set by writing data to serial data register 1 (SR1L: \$006, SR1U: \$007). Receive data of serial interface 1 is obtained by reading the contents of serial data register 1. The serial data is shifted by the transmit clock and is input from or output to an external system.

The output level of the SO₁ pin is invalid until the first data is output after MCU reset, or until the output level control in idle states is performed.

Transfer Control: Serial interface 1 is activated by the STS instruction. The octal counter is reset to 000 by the STS instruction, and it increments at the rising edge of the transmit clock for serial interface. When the eighth transmit clock signal is input or when serial transmission/reception is discontinued, the octal counter is reset to 000, the serial 1 interrupt request flag (IFS1: \$003, bit 2) for serial interface 1 is set, and the transfer stops.

When the prescaler output is selected as the transmit clock of serial interface 1, the transmit clock frequency is selected as $4t_{cyc}$ to $8192t_{cyc}$ by setting bits 0 to 2 (SM1A0–SM1A2) of serial mode register 1A (SM1A: \$005) and bit 0 (SM1B0) of serial mode register 1B (SM1B: \$028) as listed in table 26.

Table 25 Serial Interface 1 Operating Modes

SM1A	PMRA				
Bit 3	Bit 1 Bit 0		Operating Mode		
1	0	0	Continuous clock output mode		
		1	Transmit mode		
	1	0	Receive mode		
		1	Transmit/receive mode		

Table 26 Serial Transmit Clock (prescaler output)

SM1B	SM1A
------	------

Bit 0	Bit 2	Bit 1	Bit 0	Prescaler Division Ratio	Tranamit Clock Frequency	
0	0	0	0	÷ 2048	4096t _{cyc}	
			1	÷ 512	1024t _{cyc}	
		1	0	÷ 128	256t _{cyc}	
			1	÷ 32	64t _{cyc}	
	1	0	0	÷ 8	16t _{cyc}	
			1	÷2	4t _{cyc}	
1	0	0	0	÷ 4096	8192t _{cyc}	
			1	÷ 1024	2048t _{cyc}	
1		1	0	÷ 256	512t _{cyc}	
		•	1	÷ 64	128t _{cyc}	
	1	0	0	÷ 16	32t _{cyc}	
			1	÷ 4	8t _{cyc}	

Operating States: Serial interface 1 has the following operating states; transitions between them are shown in figure 50.

- STS wait state
- Transmit clock wait state
- Transfer state
- Continuous transmit clock output state (only in internal clock mode)
- STS wait state: The serial interface enters STS wait state by MCU reset (00, 10 in figure 50). In STS wait state, serial interface 1 is initialized and the transmit clock is ignored. If the STS instruction is then executed (01, 11), serial interface 1 enters transmit clock wait state.
- Transmit clock wait state: Transmit clock wait state is between the STS execution and the falling edge of the first transmit clock. In transmit clock wait state, input of the transmit clock (02, 12) increments the octal counter, shifts serial data register 1 (SR1L: \$006, SR1U: \$007), and enters the serial interface in transfer state. However, note that if continuous clock output mode is selected in internal clock mode, the serial interface does not enter transfer state but enters continuous clock output state (17).

 The serial interface enters STS wait state by writing data to serial mode register 1A (SM1A: \$005) (04, 14) in transmit clock wait state.
- Transfer state: Transfer state is between the falling edge of the first clock and the rising edge of the eighth clock. In transfer state, the input of eight clocks or the execution of the STS instruction sets the octal counter to 000, and the serial interface enters another state. When the STS instruction is executed (05, 15), transmit clock wait state is entered. When eight clocks are input, transmit clock wait state is entered (03) in external clock mode, and STS wait state is entered (13) in internal clock mode. In internal clock mode, the transmit clock stops after outputting eight clocks.

In transfer state, writing data to serial mode register 1A (SM1A: \$005) (06, 16) initializes serial interface 1, and STS wait state is entered.

If the state changes from transfer to another state, the serial 1 interrupt request flag (IFS1: \$003, bit 2) is set by the octal counter that is reset to 000.

• Continuous clock output state (only in internal clock mode): Continuous clock output state is entered only in internal clock mode. In this state, the serial interface does not transmit/receive data but only outputs the transmit clock from the SCK₁ pin.

When bits 0 and 1 (PMRA0, PMRA1) of port mode register A (PMRA: \$004) are 00 in transmit clock wait state and if the transmit clock is input (17), the serial interface enters continuous clock output state. If serial mode register 1A (SM1A: \$005) is written to in continuous clock output mode (18), STS wait state is entered.

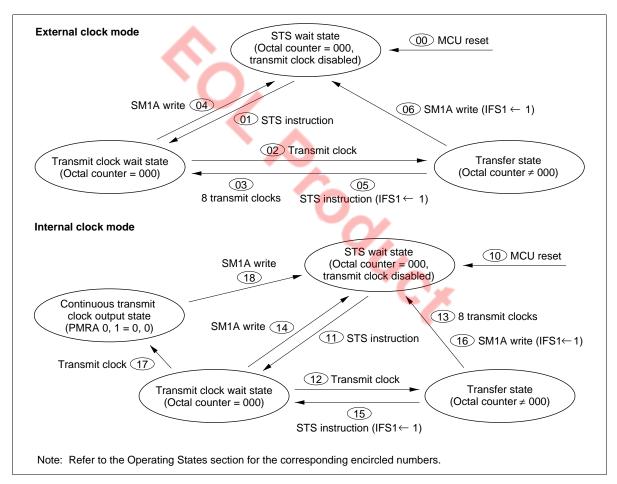


Figure 50 Serial Interface State Transitions

Output Level Control in Idle States: When serial interface 1 is in STS instruction wait state, the output of serial output pin, SO₁ can be controlled by setting bit 1 (SM1B1) of serial mode register 1B (SM1B: \$028) to 0 or 1. The output level control example of serial interface 1 is shown in Figure 51. Note that the output level cannot be controlled in transfer state.

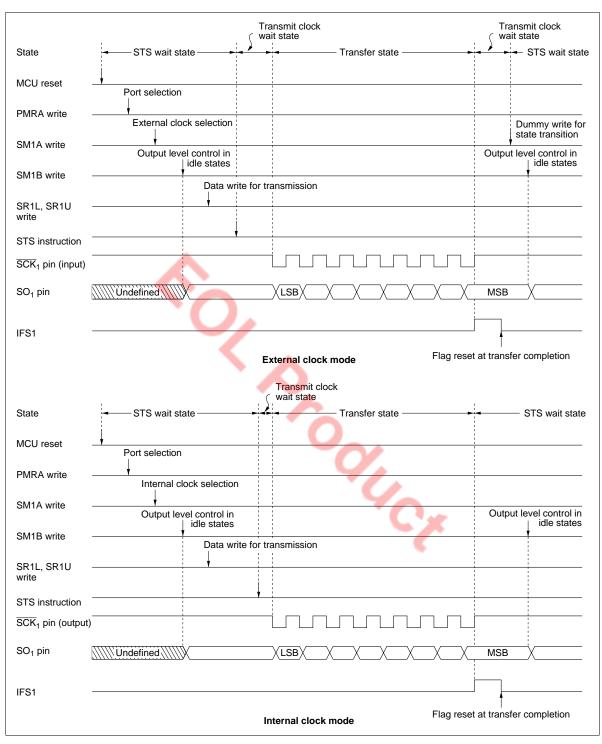


Figure 51 Example of Serial Interface 1 Operation Sequence

Transmit Clock Error Detection (In External Clock Mode): The serial interface will malfunction if a spurious pulse caused by external noise conflicts with a normal transmit clock during transfer. A transmit clock error of this type can be detected as shown in figure 52.

If more than eight transmit clocks are input in transfer state, at the eighth clock including a spurious pulse by noise, the octal counter reaches 000, the serial 1 interrupt request flag (IFS1: \$003, bit 2) is set, and transmit clock wait state is entered. At the falling edge of the next normal clock signal, the transfer state is entered. After the transfer is completed and IFS is reset, writing to serial mode register 1A (SM1A: \$005) changes the state from transfer to STS wait. At this time serial interface 1 is in the transfer state, and the serial 1 interrupt request flag is set again, and therefore the error can be detected.

Notes on Use:

- Initialization after writing to registers: If port mode register A (PMRA: \$004) is written to in transmit clock wait state or in transfer state, the serial interface must be initialized by writing to serial mode register 1A (SM1A: \$005) again.
- Serial 1 interrupt request flag (IFS1: \$003, bit 2) set: For serial interface 1, if the state is changed from transfer state to another by writing to serial mode register 1A (SM1A: \$005) or executing the STS instruction during the first low pulse of the transmit clock, the serial 1 interrupt request flag is not set. To set the serial 1 interrupt request flag, a serial mode register 1A write or STS instruction execution must be programmed to be executed after confirming that the \$\overline{SCK}_1\$ pin is at 1, that is, after executing the input instruction to port R4.

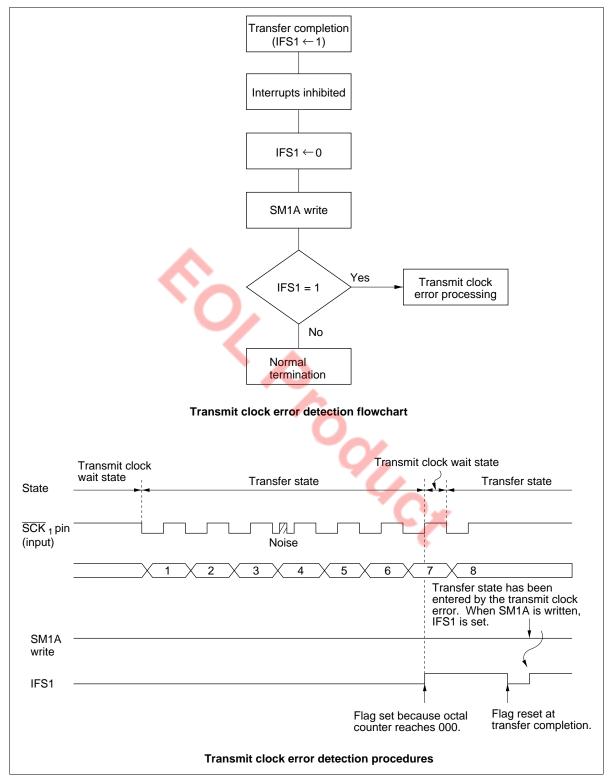


Figure 52 Transmit Clock Error Detection

Registers for Serial Interface

The serial interface operation is selected, and serial data is read and written by the following registers.

- Serial mode register 1A (SM1A: \$005)
- Serial mode register 1B (SM1B: \$028)
- Serial data register 1 (SR1L: \$006, SR1U: \$007)
- Port mode register A (PMRA: \$004)
- Miscellaneous register (MIS: \$00C)

Serial Mode Register 1A (SM1A: \$005): This register has the following functions (figure 53).

- $R4_1/\overline{SCK}_1$ pin function selection
- Serial interface 1 transmit clock selection
- Serial interface 1 prescaler division ratio selection
- Serial interface 1 initialization

Serial mode register 1A (SM1A: \$005) is a 4-bit write-only register. It is reset to \$0 by MCU reset.

A write signal input to serial mode register 1A (SM1A: \$005) discontinues the input of the transmit clock to serial data register 1 (SR1L: \$006, SR1U: \$007) and the octal counter, and the octal counter is reset to 000. Therefore, if a write is performed during data transfer, the serial 1 interrupt request flag (IFS1: \$003, bit 2) is set.

Written data is valid from the second instruction execution cycle after the write operation, so the STS instruction must be executed at least two cycles after that.

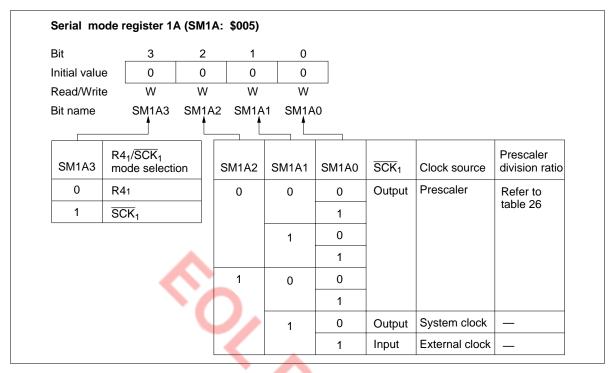


Figure 53 Serial Mode Register 1A (SM1A)

Serial Mode Register 1B (SM1B: \$028): This register has the following functions (figure 54).

- Serial interface 1 prescaler division ratio selection
- Serial interface 1 output level control in idle states

Serial mode register 1B (SM1B: \$028) is a 2-bit write-only register. It cannot be written during data transfer.

By setting bit 0 (SM1B0) of this register, the serial interface 1 prescaler division ratio is selected. Only bit 0 (SM1B0) can be reset to 0 by MCU reset. By setting bit 1 (SM1B1), the output level of the SO_1 pin is controlled in idle states of serial interface 1. The output level changes at the same time that SM1B1 is written to.

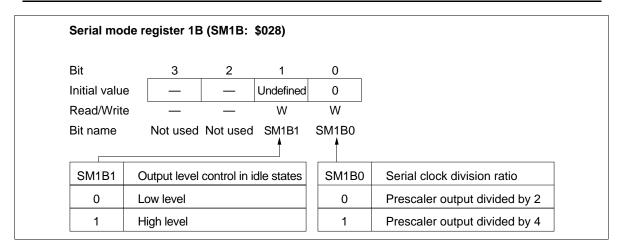


Figure 54 Serial Mode Register 1B (SM1B)

Serial Data Register 1 (SR1L: \$006, SR1U: \$007): This register has the following functions (figures 55 and 56)

- Serial interface 1 transmission data write and shift
- Serial interface 1 receive data shift and read

Writing data in this register is output from the SO_1 pin, LSB first, synchronously with the falling edge of the transmit clock; data is input, LSB first, through the SI_1 pin at the rising edge of the transmit clock. Input/output timing is shown in figure 57.

Data cannot be read or written during serial data transfer. If a read/write occurs during transfer, the accuracy of the resultant data cannot be guaranteed.

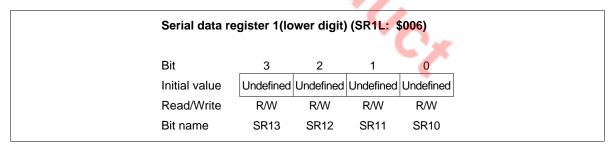


Figure 55 Serial Data Register 1 (SR1L)

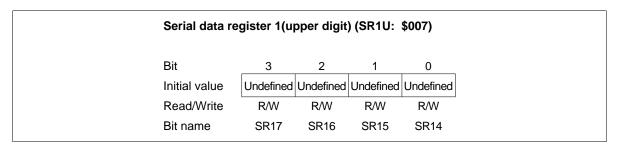


Figure 56 Serial Data Register 1 (SR1U)

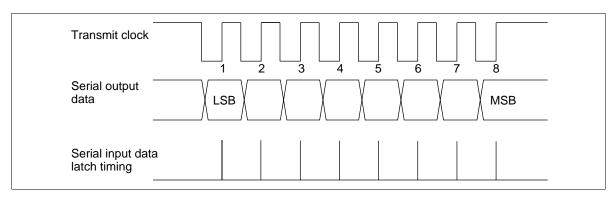


Figure 57 Serial Interface Output Timing

Port Mode Register A (PMRA: \$004): This register has the following functions (figure 58).

- R4₂/SI₁ pin function selection
- R4₃/SO₁ pin function selection

Port mode register A (PMRA: \$004) is a 2-bit write-only register, and is reset to \$0 by MCU reset.

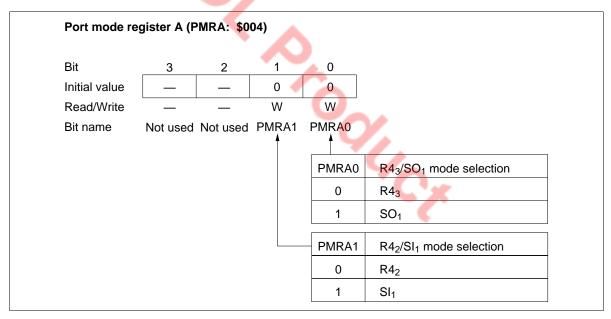


Figure 58 Port Mode Register A (PMRA)

Miscellaneous Register (MIS: \$00C): This register has the following functions (figure 59).

• R4₃/SO₁ pin PMOS control

Miscellaneous register (MIS: \$00C) is a 2-bit write-only register and is reset to \$0 by MCU reset.

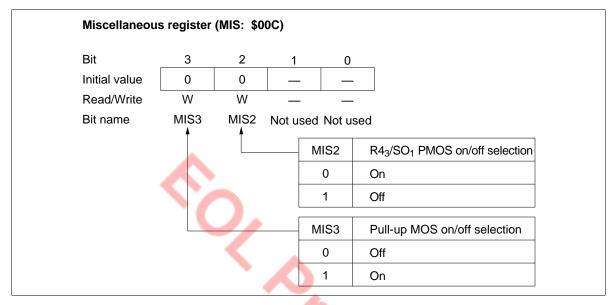


Figure 59 Miscellaneous Register (MIS)

Comparator

The block diagram of the comparator is shown in figure 60. The comparator compares input voltage with the reference voltage.

Setting 1 to bit 3 (CER3) of the compare enable register (CER: \$018) executes a voltage comparison. When an input voltage at COMP₀, COMP₁ is higher than the reference voltage, the TM or TMD command sets the status flag (ST) high for the corresponding bits of the compare data register (CDR: \$017) to COMP₀ and COMP₁. On the other hand, when an input voltage at COMP₀, COMP₁ is lower, the TM or TMD command clears the ST to 0.

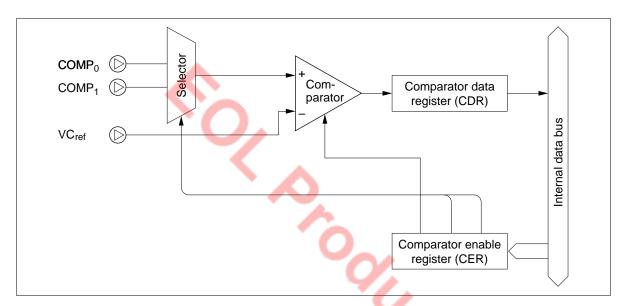


Figure 60 Block Diagram of Comparator

Compare Enable Register (CER: \$018): Three-bit write-only register which enables comparator operation, and selects the reference voltage and the analog input pin (figure 61).

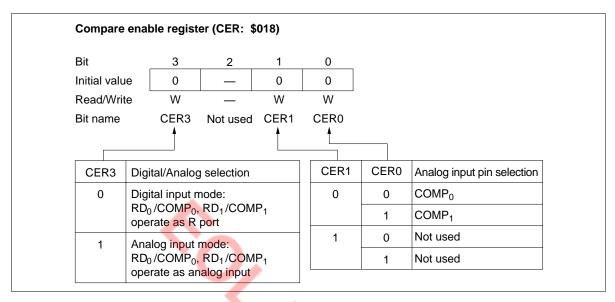


Figure 61 Compare Enable Register

Compare Data Register (CDR: \$017): Two-bit read-only register which latches the result of the comparison between the analog input pins and the reference voltage. Bits 0 and 1 corresponds the results of comparison with COMP₀ and COMP₁, respectively. This register can be read only by the TM or TMD command. Only bit CER3 corresponds to the analog input pin which the input pin selection is made through pins CER0 and CER1. After a compare operation, the data in this register is not retained (figure 62).

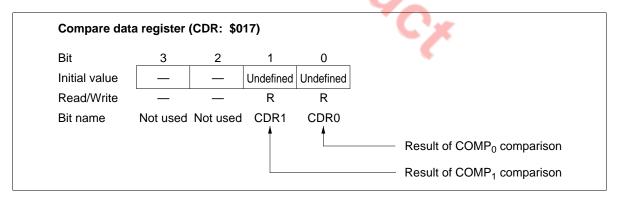


Figure 62 Compare Data Register

Note on Use: During the compare operation pins RD₀/COMP₀ and RD₁/COMP₁ operate as analog inputs and cannot operate as R ports.

The comparator can operate in active mode but is disabled in other modes.

RE₀/VC_{ref} cannot operate as an R port when the external input voltage is selected as the reference.

Programmable ROM (HD4074054, HD4074094)

The HD4074054 and HD4074094 are ZTAT $^{\text{TM}}$ microcomputers with built-in PROM that can be programmed in PROM mode.

PROM Mode Pin Description

Pin No.		MCU Mode		PROM Mode	
DP-42S	FP-44A	Pin Name	I/O	Pin Name	I/O
1	39	RD ₀ /COMP ₀	1	CE	1
2	40	RD ₁ /COMP ₁	1	ŌĒ	I
3	41	RD ₂	I		
4	42	RD_3	1		
5	43	RC ₀	I		
6	1	RE ₀ /VC _{ref}	I	$\overline{M}_{\scriptscriptstyle{1}}$	I
7	2	TEST	1	TEST	1
8	3	OSC ₁	1	V_{cc}	
9	4	OSC ₂	0		
10	5	RESET		RESET	1
11	6	GND	<u> </u>	GND	
12	7	D ₀	I/O		0
13	8	D ₁	I/O		0
14	9	$D_{\!\scriptscriptstyle 2}$	I/O	V_{cc}	
15	10	D_3	I/O	V _{cc}	
16	11	D_4	I/O*	O_4	I/O
17	12	D_5	I/O*	O_5	I/O
18	13	D_6	I/O*	O_6	I/O
19	14	D ₇	I/O*	O ₇	I/O
20	15	D_8	I/O	A ₁₃	1
21	16	D_{9}	I/O	A ₁₄	1
22	17	D ₁₂ /STOPC	1	A_9	I
23	18	D_{13}/\overline{INT}_0	1	V _{PP}	
24	19	R0 ₀ /INT ₁	I/O	\overline{M}_{o}	ı
25	20	R1 ₀	I/O	A ₅	I
26	21	R1 ₁	I/O	A ₆	ı
27	23	R1 ₂	I/O	A ₇	I

Note: I/O: Input/output pin, I: Input pin, O: Output pin * HD404054 Series: I/O, HD404094 Series: O

HD404054 Series/HD404094 Series

Pin No.		MCU Mode		PROM Mode	
DP-42S	FP-44A	Pin Name	I/O	Pin Name	I/O
28	24	R1 ₃	I/O	A ₈	I
29	25	R2 ₀	I/O	A _o	I
30	26	R2₁	I/O	A ₁₀	I
31	27	R2 ₂	I/O	A ₁₁	I
32	28	R2 ₃	I/O	A ₁₂	I
33	29	R3 ₀	I/O	A ₁	I
34	30	R3₁/TOC	I/O	A_2	I
35	31	R3 ₂ /TOD	I/O	A_3	I
36	32	R3 ₃	I/O	A ₄	I
37	33	R4 ₀ /EVND	I/O	O ₀	I/O
38	34	R4 ₁ /SCK ₁	I/O	O ₁	I/O
39	35	R4 ₂ /SI ₁	I/O	O ₂	I/O
40	36	R4 ₃ /SO ₁	I/O	O ₃	I/O
41	37	SEL	I		
42	38	V _{cc}	<u> I</u>	V _{cc}	
_	22	NC	<u> </u>		
_	44	NC	A		
Note: I/O: I	nput/output pin, I: I	nput pin, O: Output	pin	CA	

Programming the Built-In PROM

The MCU's built-in PROM is programmed in PROM mode. PROM mode is set by pulling $\overline{\text{TEST}}$, \overline{M}_0 , and \overline{M}_1 low, and $\overline{\text{RESET}}$ low as shown in figure 63. In PROM mode, the MCU does not operate, but it can be programmed in the same way as any other commercial 27256-type EPROM using a standard PROM programmer and an 42-to-28-pin socket adapter. Recommended PROM programmers and socket adapters of the HD4074054 and HD4074094 are listed in table 27.

Since an HMCS400-series instruction is ten bits long, the HMCS400-series MCU has a built-in conversion circuit to enable the use of a general-purpose PROM programmer. This circuit splits each instruction into five lower bits and five upper bits that are read from or written to consecutive addresses. This means that if, for example, 4-kwords of built-in PROM are to be programmed by a general-purpose PROM programmer, a 8-kbyte address space (\$0000-\$7FFF) must be specified.

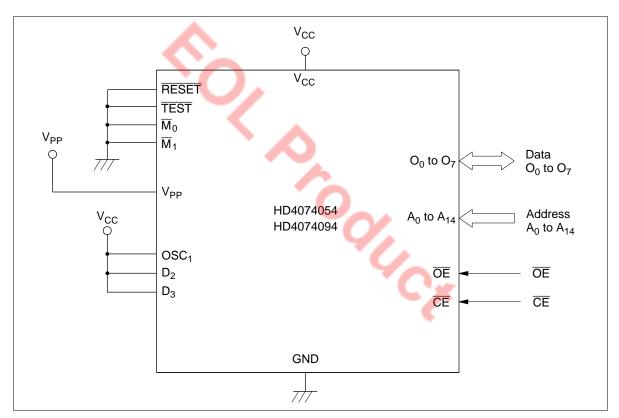


Figure 63 PROM Mode Connections

Table 27 Recommended PROM Programmers and Socket Adapters

PROM Programmer		Socket Adapter		
Manufacturer	Model Name	Package	Model Name	Manufacturer
DATA I/O Corp.	121B	DP-42S	HS4654ESS01H	Hitachi
AVAL Corp.	PKW-1000	FP-44A	HS4654ESH01H	Hitachi

Warnings

1. Always specify addresses \$0000 to \$1FFF when programming with a PROM programmer. If address \$2000 or higher is accessed, the PROM may not be programmed or verified correctly. Set all data in unused addresses to \$FF.

Note that the plastic-package version cannot be erased or reprogrammed.

- 2. Make sure that the PROM programmer, socket adapter, and LSI are aligned correctly (their pin 1 positions match), otherwise overcurrents may damage the LSI. Before starting programming, make sure that the LSI is firmly fixed in the socket adapter and the socket adapter is firmly fixed onto the programmer.
- 3. PROM programmers have two voltages (V_{PP}) : 12.5 V and 21 V. Remember that ZTATTM devices require a V_{PP} of 12.5 V—the 21-V setting will damage them. 12.5 V is the Intel 27256 setting.

Programming and Verification

The built-in PROM of the MCU can be programmed at high speed without risk of voltage stress or damage to data reliability.

Programming and verification modes are selected as listed in table 28.

Table 28 PROM Mode Selection

	Pin			
Mode	CE	ŌĒ	V _{PP}	O ₀ -O ₇
Programming	Low	High	V_{PP}	Data input
Verification	High	Low	V _{PP}	Data output
Programming inhibited	High	High	V _{PP}	High impedance

Addressing Modes

RAM Addressing Modes

The MCU has three RAM addressing modes, as shown in figure 64 and described below.

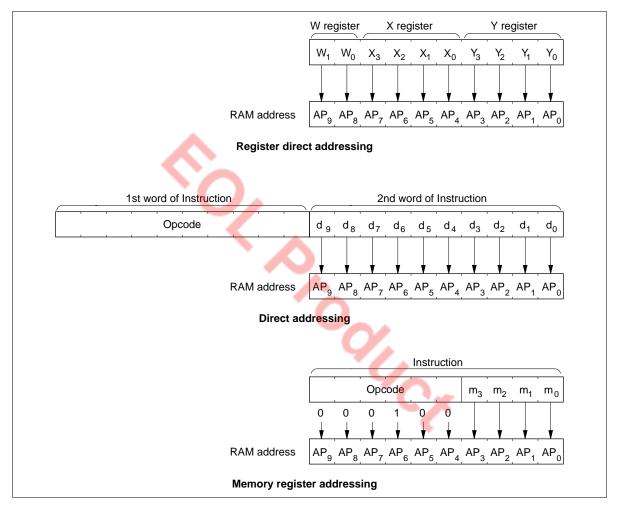


Figure 64 RAM Addressing Modes

Register Indirect Addressing Mode: The contents of the W, X, and Y registers (10 bits in total) are used as a RAM address.

Direct Addressing Mode: A direct addressing instruction consists of two words. The first word contains the opcode, and the contents of the second word (10 bits) are used as a RAM address.

Memory Register Addressing Mode: The memory registers (MR), which are located in 16 addresses from \$040 to \$04F, are accessed with the LAMR and XMRA instructions.

ROM Addressing Modes and the P Instruction

The MCU has four ROM addressing modes, as shown in figure 65 and described below.

Direct Addressing Mode: A program can branch to any address in the ROM memory space by executing the JMPL, BRL, or CALL instruction. Each of these instructions replaces the 14 program counter bits $(PC_{13}-PC_0)$ with 14-bit immediate data.

Current Page Addressing Mode: The MCU has 64 pages of ROM with 256 words per page. A program can branch to any address in the current page by executing the BR instruction. This instruction replaces the eight low-order bits of the program counter (PC_7-PC_0) with eight-bit immediate data. If the BR instruction is on a page boundary (address 256n + 255), executing that instruction transfers the PC contents to the next physical page, as shown in figure 67. This means that the execution of the BR instruction on a page boundary will make the program branch to the next page.

Note that the HMCS400-series cross macroassembler has an automatic paging feature for ROM pages.

Zero-Page Addressing Mode: A program can branch to the zero-page subroutine area located at \$0000–\$003F by executing the CAL instruction. When the CAL instruction is executed, 6 bits of immediate data are placed in the six low-order bits of the program counter (PC_5-PC_0) , and 0s are placed in the eight high-order bits $(PC_{13}-PC_6)$.

Table Data Addressing Mode: A program can branch to an address determined by the contents of four-bit immediate data, the accumulator, and the B register by executing the TBR instruction.

P Instruction: ROM data addressed in table data addressing mode can be referenced with the P instruction as shown in figure 66. If bit 8 of the ROM data is 1, eight bits of ROM data are written to the accumulator and the B register. If bit 9 is 1, eight bits of ROM data are written to the R1 and R2 port output registers. If both bits 8 and 9 are 1, ROM data is written to the accumulator and the B register, and also to the R1 and R2 port output registers at the same time.

The P instruction has no effect on the program counter.

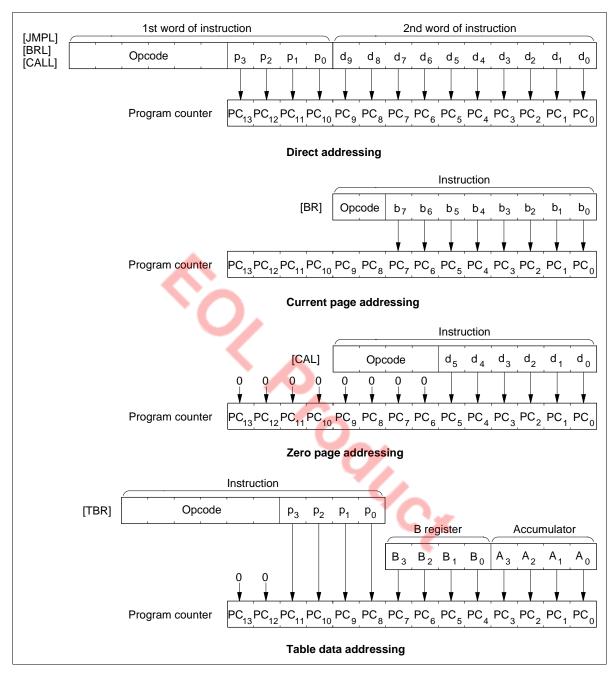


Figure 65 ROM Addressing Modes

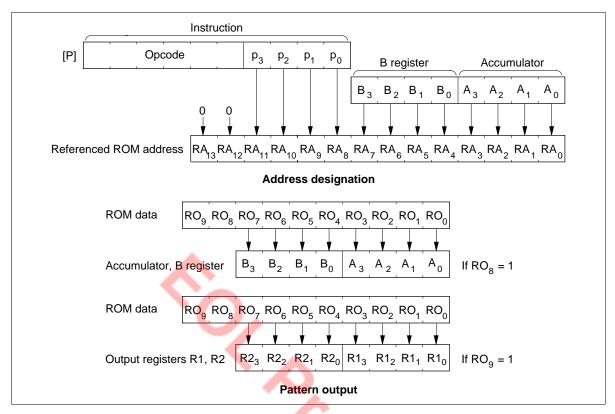


Figure 66 P Instruction

Of CX

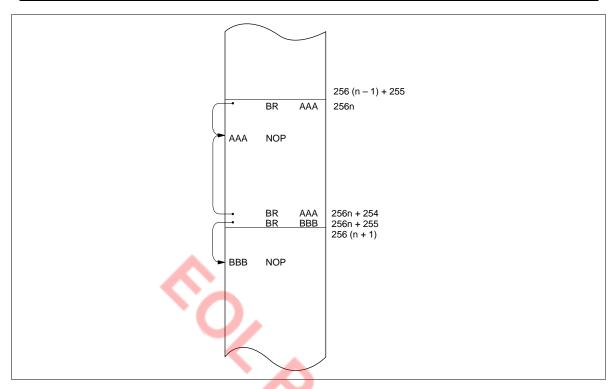


Figure 67 Branching when the Branch Destination is on a Page Boundary

OOLCX

Absolute Maximum Ratings

Item	Symbol	Value	Unit	Notes
Supply voltage	V _{cc}	-0.3 to +7.0	V	
Programming voltage	V _{PP}	-0.3 to +14.0	V	1
Pin voltage	V _T	-0.3 to V_{cc} + 0.3	V	
		-0.3 to +15.0	V	2
Total permissible input current	Σ I $_{\circ}$	80	mA	3
Total permissible output current	$-\Sigma I_{\circ}$	50	mA	4
Maximum input current	I _o	4	mA	5, 6
		30	mA	5, 7
Maximum output current	-I _o	4	mA	8, 9
		20	mA	8, 10
Operating temperature	Topr	-20 to +75	°C	
Storage temperature	T _{stg}	-55 to +125	°C	

Notes: Permanent damage may occur if these absolute maximum ratings are exceeded. Normal operation must be under the conditions stated in the electrical characteristics tables. If these conditions are exceeded, the LSI may malfunction or its reliability may be affected.

- 1. Applies to D₁₃ (V_{PP}) of HD4074054 and HD4074094.
- 2. Applies to D₄ to D₇ of HD404092, HD404094, and HD4074094.
- 3. The total permissible input current is the total of input currents simultaneously flowing in from all the I/O pins to GND.
- 4. The total permissible output current is the total of output currents simultaneously flowing out from V_{cc} to all I/O pins.
- 5. The maximum input current is the maximum current flowing from each I/O pin to GND.
- 6. Applies to D₀-D₃, and R0-R4.
- 7. Applies to D₄–D₉.
- 8. The maximum output current is the maximum current flowing out from V_{cc} to each I/O pin.
- 9. Applies to D₄-D₉ and R0-R4.
- 10. Applies to D_0-D_3 .

Electrical Characteristics

DC Characteristics (HD404052, HD404054, HD404092, HD404094: V_{CC} = 1.8 V to 6.0 V, GND = 0 V, T_a = -20 °C to +75 °C; HD40A4052, HD40A4054: V_{CC} = 4.0 V to 6.0 V, GND = 0 V, T_a = -20 °C to +75 °C; HD4074054, HD4074094: V_{CC} = 2.7 V to 5.5 V, GND = 0 V, T_a = -20 °C to +75 °C, unless otherwise specified)

Item	Symbol	Pin(s)	Min	Тур	Max	Unit	Test Condition	Notes
Input high voltage	V _{IH}	RESET, STOPC, INT ₀ , INT ₁ , SCK ₁ , SI ₁ , EVND	0.9 V _{cc}	_	V _{cc} + 0.3	V		
		OSC ₁	$V_{\rm CC}-0.3$	_	V _{cc} + 0.3	V	External clock	
Input low voltage	V _{IL}	RESET, STOPC, INT ₀ , INT ₁ , SCK ₁ , SI ₁ , EVND	-0.3	_	0.10 V _{cc}	V		
		OSC ₁	-0.3	_	0.3	V	External clock	
Output high voltage	V_{OH}	SCK ₁ , SO ₁ , TOC,TOD	V _{cc} – 1.0	_	_	V	$-I_{OH} = 0.5 \text{ mA}$	
Output low voltage	V _{oL}	SCK ₁ , SO ₁ , TOC,TOD	<u>-</u>	_	0.4	V	I _{OL} = 0.4 mA	
I/O leakage current	I _{IL}	RESET, STOPC, INT ₀ , INT ₁ , SCK ₁ , SI ₁ , SO ₁ , EVND, OSC ₁ , TOC, TOD	_	O	1	μΑ	$V_{in} = 0 \text{ V to } V_{CC}$	1
Current dissipation in active mode	I _{CC1}	V _{cc}	_	5	₹,	mA	$V_{CC} = 5 \text{ V},$ $f_{OSC} = 4 \text{ MHz}$ Digital input mode	2, 4,
			_	5	10	mA	$V_{cc} = 5 \text{ V},$ $f_{osc} = 8 \text{ MHz}$ Digital input mode	3, 4,
	I _{CC2}	V _{cc}	_	0.6	1.8	mA	$V_{cc} = 3 \text{ V},$ $f_{osc} = 800 \text{ kHz}$ Digital input mode	2, 4,
	I _{CMP1}	V _{cc}	_	9	_	mA	$V_{CC} = 5 \text{ V},$ $f_{OSC} = 4 \text{ MHz}$ Analog comp. mode	2, 4,
			_	9	15	mA	V_{cc} = 5 V, f_{osc} = 8 MHz Analog comp. mode	3, 4,
	I _{CMP2}	V _{cc}	_	3.1	4.3	mA	$V_{cc} = 3 \text{ V},$ $f_{osc} = 800 \text{ kHz}$ Analog comp. mode	2, 4,

Item	Symbol	Pin(s)	Min	Тур	Max	Unit	Test Condition	Notes
Current dissipation in standby mode	I _{SBY1}	V _{CC}	_	1.2	_	mA	$V_{CC} = 5 \text{ V},$ $f_{OSC} = 4 \text{ MHz}$	2, 6,
			_	3	6	mA	$V_{CC} = 5 \text{ V},$ $f_{OSC} = 8 \text{ MHz}$	3, 6,
	I _{SBY2}	V _{cc}	_	0.2	0.7	mA	$V_{CC} = 3 \text{ V},$ $f_{OSC} = 800 \text{ kHz}$	2, 6,
Current dissipation in stop mode	I _{STOP}	V _{cc}	_	1	5	μΑ	$V_{CC} = 3 \text{ V}$	2, 7
			_	1	10	μΑ	$V_{CC} = 5 V$	3, 7
Stop mode retaining voltage	V _{STOP}	V _{CC}	_	1.3	_	V		8
Comparator input reference voltage scope	VC _{ref}	VC _{ref}	0	_	V _{CC} - 1.2	: V		

Notes: 1. Output buffer current is excluded.

- 2. Applies to HD404052, HD404054, HD4074054, HD404092, HD404094 and HD4074094.
- 3. Applies to HD40A4052 and HD40A4054.
- 4. I_{CC1} and I_{CC2} are the source currents when no I/O current is flowing while the MCU is in reset state. Test conditions: MCU: Reset Pins: RESET at GND (0 V to 0.3V) $\overline{\text{TEST}}$ at V_{cc} (V_{cc} – 0.3 to V_{cc})
- 5. RD₀ and RD₁ pins are analog input mode when no I/O current is flowing.

Test conditions: MCU: Analog input mode Pins: RD₀/COMP₀ at GND (0 V to 0.3 V) RD₁/COMP₁ at GND (0 V to 0.3 V) RE_0/VC_{ref} at GND (0 V to 0.3 V)

6. I_{SBY1} and I_{SBY2} are the source currents when no I/O current is flowing while the MCU timer is operating. Test conditions: MCU: I/O reset

Serial interface stopped

Standby mode

Pins: \overline{RESET} at V_{cc} ($V_{cc} - 0.3$ to V_{cc})

 $\overline{\text{TEST}}$ at V_{cc} ($V_{cc} - 0.3$ to V_{cc})

7. These are the source currents when no I/O current is flowing.

Test conditions: Pins: \overline{RESET} at V_{cc} ($V_{cc} - 0.3$ to V_{cc})

 $\overline{\text{TEST}} \text{ at V}_{\text{CC}} \left(\text{V}_{\text{CC}} - 0.3 \text{ to V}_{\text{CC}} \right) \\ \text{D}_{13}^* \text{ at V}_{\text{CC}} \left(\text{V}_{\text{CC}} - 0.3 \text{ to V}_{\text{CC}} \right)$

Note: * Applies to HD4074054 and HD4074094

8. RAM data retention.

I/O Characteristics for Standard Pins (HD404052, HD404054, HD404092, HD404094: V_{CC} = 1.8 V to 6.0 V, GND = 0 V, T_a = -20°C to +75°C; HD40A4052, HD40A4054: V_{CC} = 4.0 V to 6.0 V, GND = 0 V, T_a = -20°C to +75°C; HD4074054, HD4074094: V_{CC} = 2.7 V to 5.5 V, GND = 0 V, T_a = -20°C to +75°C, unless otherwise specified)

Item	Symbol	Pin(s)	Min	Тур	Max	Unit	Test Condition	Notes
Input high voltage	V_{IH}	D ₁₂ –D ₁₃ , R0–RD, RE ₀	0.7 V _{cc}	_	V _{cc} + 0.3	V		
Input low voltage	V_{IL}	D ₁₂ –D ₁₃ , R0–RD, RE ₀	-0.3	_	0.3 V _{cc}	V		
Output high voltage	V_{OH}	R0-R4	V _{cc} – 1.0	_	_	V	$-I_{OH} = 0.5 \text{ mA}$	
Output low voltage	V _{OL}	R0-R4	_	_	0.4	V	I _{OL} = 0.4 mA	
I/O leakage current	I _{IL}	D ₁₂ , R0–RD, RE ₀	_	_	1	μΑ	$V_{in} = 0 \text{ V to } V_{CC}$	1
		D ₁₃	1	_	1	μΑ	$V_{in} = 0 \text{ V to } V_{CC}$	1, 2, 4
			<		1	μΑ	$V_{in} = V_{CC} - 0.3 \text{ V to } V_{CC}$	1, 3
				6	20	μΑ	$V_{in} = 0 V \text{ to } 0.3 V$	1, 3
Pull-up MOS current	-I _{PU}	R0-R4	_	30	_	μΑ	$V_{CC} = 3 V,$ $V_{in} = 0 V$	2, 3
			20	100	500	μΑ	$V_{CC} = 5 V$, $V_{in} = 0 V$	4
Input high voltage	V_{IHA}	COMP ₀ , COMP ₁	_	VC _{ref} +0.0 5	4	V	Analog compare mode	5
Input low voltage	V_{ILA}	COMP ₀ , COMP ₁	_	VC _{ref} -0.05	5 —	V	Analog compare mode	5

Notes: 1. Output buffer current is excluded.

- 2. Applies to HD404052, HD404054, HD404092, HD404094.
- 3. Applies to HD4074054, HD4074094.
- 4. Applies to HD40A4052, HD40A4054.
- 5. The analog input reference voltage should be in the range $0 \le VC_{ref} \le V_{CC} 1.2$.

I/O Characteristics for High-Current Pins and Intermediate-Voltage Pins (HD404052, HD404054, HD404092, HD404094: $V_{CC}=1.8~V$ to 6.0 V, GND = 0 V, $T_a=-20^{\circ}C$ to +75°C; HD40A4052, HD40A4054: $V_{CC}=4.0~V$ to 6.0 V, GND = 0 V, $T_a=-20^{\circ}C$ to +75°C; HD4074054, HD4074094: $V_{CC}=2.7~V$ to 5.5 V, GND = 0 V, $T_a=-20^{\circ}C$ to +75°C, unless otherwise specified)

		Pin(s)							
Item	Symbol	HD404054 Series	HD404094 Series	Min	Тур	Max	Unit	Test Condition	Notes
Input high voltage	V_{IH}	D ₀ –D ₉	D ₀ -D ₃ , D ₈ , D ₉	0.7 V _{cc}	_	V _{cc} + 0.3	V		
Input low voltage	V_{IL}	D ₀ –D ₉	D ₀ -D ₃ , D ₈ , D ₉	-0.3	_	0.3 V _{cc}	V		
Output high voltage	V _{OH}	D ₀ -D ₉	D ₀ -D ₃ , D ₈ , D ₉	V _{CC} - 1.0	_	_	V	$-I_{OH} = 0.5 \text{ mA}$	
		D ₀ –D ₃	D ₀ -D ₃	2.0	_	_	V	$-I_{OH} = 10 \text{ mA},$ $V_{CC} = 4.5 \text{ V to}$ 6.0 V	2
		_	D ₄ -D ₇	11.5	_	_	V	500 kΩ at 12 V	
Output low voltage	V _{OL}	D ₀ –D ₉	D ₀ –D ₉	<u></u>	_	0.4	V	I _{OL} = 0.4 mA	
		D ₄ –D ₉	D ₄ –D ₉	1	_	2.0	V	$I_{OL} = 15 \text{ mA},$ $V_{CC} = 4.5 \text{ V to}$ 6.0 V	2
I/O leakage current	I _{IL}	D ₀ –D ₉	D ₀ -D ₃ , D ₈ , D ₉	- C	6	1	μА	$V_{in} = 0 \text{ V to } V_{CC}$	1
		_	D ₄ –D ₇	_	7	20	μΑ	$V_{in} = 0 \text{ V to}$ 12 V	1
Pull-down MOS current	I _{PD}	D ₀ -D ₃	D ₀ –D ₃	_	30	-C	μА	$V_{cc} = 3 \text{ V},$ $V_{in} = 3 \text{ V}$	3
			_	20	100	500	μА	$V_{cc} = 5 \text{ V},$ $V_{in} = 5 \text{ V}$	4
Pull-up MOS current	-I _{PU}	D ₄ –D ₉	D ₈ , D ₉	_	30	_	μА	$V_{cc} = 3 \text{ V},$ $V_{in} = 0 \text{ V}$	3
			_	20	100	500	μΑ	$V_{CC} = 5 \text{ V},$ $V_{in} = 0 \text{ V}$	4

Notes: 1. Output buffer current is excluded.

- 2. When using HD4074054, HD4074094, $V_{\rm CC}$ = 4.5 V to 5.5 V.
- 3. Applies to HD404052, HD404054, HD4074054, HD404092, HD404094, HD4074094.
- 4. Applies to HD40A4052, HD40A4054.

AC Characteristics (HD404052, HD404054, HD404092, HD404094: V_{CC} = 1.8 V to 6.0 V, GND = 0 V, T_a = -20 °C to +75 °C; HD40A4052, HD40A4054: V_{CC} = 4.0 V to 6.0 V, GND = 0 V, T_a = -20 °C to +75 °C; HD4074054, HD4074094: V_{CC} = 2.7 V to 5.5 V, GND = 0 V, T_a = -20 °C to +75 °C, unless otherwise specified)

Item	Symbol	Pin(s)	Min	Тур	Max	Unit	Test Condition	Notes
Clock oscillation frequency	f _{osc}	OSC ₁ , OSC ₂	0.4	_	4	MHz		1
			0.4	_	8.5	MHz		2
Instruction cycle time	t _{cyc}	-	_	8	_	μs	f _{OSC} = 4 MHz, ÷32	1, 4
			_	3.76	_	μs	f _{OSC} = 8.5 MHz, ÷32	2, 4
			_	1	_	μs	f _{OSC} = 4 MHz, ÷4	1, 3
			_	0.47	_	μs	f _{osc} = 8.5 MHz, ÷4	2, 3
Oscillation stabilization time (ceramic)	t _{RC}	OSC ₁ , OSC ₂	_	_	7.5	ms	V _{cc} = 2.7 V to 5.5 V: HD4074054, HD4074094	3, 4
		Q,					V _{cc} = 2.7 V to 6.0 V: HD404052, HD404054, HD404092, HD404094	
			Z		60	ms	V _{cc} = 1.8 V to 2.7 V: HD404052, HD404054, HD404092, HD404094	
			- •	7	7.5	ms	V _{CC} = 4.0 V to 6.0 V: HD40A4052,HD40A4054	5, 6
External clock high width	t _{CPH}	OSC ₁	105		0	ns		1, 7
			49	_		ns		2, 7
External clock low width	t _{CPL}	OSC ₁	105	_	_	ns	7	1, 7
			49	_	_	ns		2, 7
External clock rise time	t_{CPr}	OSC ₁	_	_	20	ns		1, 7
			_	_	10	ns		2, 7
External clock fall time	t_{CPf}	OSC ₁	_	_	20	ns		1, 7
			_	_	10	ns		2, 7
INT₀, INT₁, EVND high width	t _{IH}	ĪNT₀, ĪNT₁, EVND	2	_	_	t _{cyc}		8
ĪNT₀, ĪNT₁, EVND low width	t _{IL}	ĪNT₀, ĪNT₁, EVND	2	_	_	t _{cyc}		8
RESET low width	t _{RSTL}	RESET	2	_	_	$t_{\rm cyc}$		9
STOPC low width	t _{STPL}	STOPC	1		_	t _{RC}		10
RESET rise time	t _{RSTr}	RESET	_		20	ms		9
STOPC rise time	t _{STPr}	STOPC	_	_	20	ms		10

Item	Symbol	Pin(s)	Min	Тур	Max	Unit	Test Condition	Notes
Input capacitance	C_{in}	All pins except D ₁₃ D ₄ –D ₇	_	_	15	pF	$f = 1 \text{ MHz}, V_{in} = 0 \text{ V}$	
		D ₄ -D ₇	_	_	30	pF	$f = 1 \text{ MHz}, V_{in} = 0 \text{ V}$	
		D13	_	_	15	pF	f = 1 MHz, V _{in} = 0 V: HD404052, HD404054, HD404092, HD404094, HD40A4052,HD40A4054	
			_	_	180	pF	f = 1 MHz, V _{in} = 0 V: HD4074054, HD4074094	
Analog comparator stabilization time	t _{CSTB}	COMP ₀ , COMP ₁	_	_	2	t _{cyc}	V _{cc} = 2.7 V to 5.5 V: HD4074054, HD4074094	9
							V _{cc} = 2.7 V to 6.0 V: HD404052, HD404054, HD404092, HD404094	
	4		_	_	4	t _{cyc}	V _{CC} = 4.0 V to 6.0 V: HD40A4052,HD40A4054	11
		10,		_	20	t _{cyc}	V _{cc} = 1.8 V to 2.7 V: HD404052, HD404054, HD404092, HD404094	

Notes: 1. Applies to HD404052, HD404054, HD4074054, HD404092, HD404094, HD4074094.

- 2. Applies to HD40A4052, HD40A4054.
- 3. SEL = 1
- 4. SEL = 0
- 5. The oscillation stabilization time is the period required for the oscillator to stabilize after V $_{\rm CC}$ reaches 2.7 (HD4074054, HD4074094)/1.8 (HD404052, HD404054, HD404092, HD404094) /4.0 (HD40A4052, HD40A4054)V at power-on, or after RESET input goes low or STOPC input goes low when stop mode is cancelled. At power-on or when stop mode is cancelled, RESET or STOPC must be input for at least $t_{\rm RC}$ to ensure the oscillation stabilization time. If using a ceramic oscillator, contact its manufacturer to determine what stabilization time is required, since it will depend on the circuit constants and stray capacitance.
- 6. Applies to ceramic oscillator only.
- 7. Refer to figure 68.
- 8. Refer to figure 69.
- 9. Refer to figure 70.
- 10. Refer to figure 71.
- 11. Analog comparator stabilization time is the period for the analog comparator to stabilize and for correct data to be read after entering RD₀/COMP₀, RD₁/COMP₁ into analog input mode.

Serial Interface Timing Characteristics (HD404052, HD404054, HD404092, HD404094: V_{CC} = 1.8 V to 6.0 V, GND = 0 V, T_a = -20°C to +75°C; HD40A4052, HD40A4054: V_{CC} = 4.0 V to 6.0 V, GND = 0 V, T_a = -20°C to +75°C; HD4074054, HD4074094: V_{CC} = 2.7 V to 5.5 V, GND = 0 V, T_a = -20°C to +75°C, unless otherwise specified)

During Transmit Clock Output

Item	Symbol	Pin(s)	Min	Тур	Max	Unit	Test Condition	Note
Transmit clock cycle time	t _{Scyc}	SCK₁	1	_	_	t _{cyc}	Load shown in figure 73	1
Transmit clock high width	t _{sckh}	SCK₁	0.5	_	_	t _{Scyc}	Load shown in figure 73	1
Transmit clock low width	t _{SCKL}	SCK₁	0.5	_	_	t _{Scyc}	Load shown in figure 73	1
Transmit clock rise time	t _{SCKr}	SCK₁	_	100	_	ns	Load shown in figure 73	1, 2
		1	•	_	80	ns	_	1, 3
Transmit clock fall time	t _{SCKf}	SCK₁	7	100	_	ns	Load shown in figure 73	1, 2
				A	80	ns	_	1, 3
Serial output data delay time	t _{DSO}	SO ₁	_ 🧖	7	500	ns	Load shown in figure 73	1, 2
			_		200	ns	_	1, 3
Serial input data setup time	t _{ssı}	SI₁	300	_	0	ns	_	1, 2
			150	_		ns	_	1, 3
Serial input data hold time	t _{HSI}	SI ₁	300	_	_	ns	•	1, 2
			150	_	_	ns		1, 3

Note: 1. Refer to figure 72.

^{2.} Applies to HD404052, HD404054, HD404092, HD404094, HD4074054, HD4074094.

^{3.} Applies to HD40A4052, HD40A4054.

During Transmit Clock Input

Item	Symbol	Pin(s)	Min	Тур	Max	Unit	Test Condition	Note
Transmit clock cycle time	t _{Scyc}	SCK₁	1	_	_	t _{cyc}		1
Transmit clock high width	t _{SCKH}	SCK₁	0.5	_	_	t _{Scyc}		1
Transmit clock low width	t _{SCKL}	SCK₁	0.5	_	_	t _{Scyc}		1
Transmit clock rise time	t _{SCKr}	SCK₁	_	100	_	ns		1, 2
			_	_	80	ns		1, 3
Transmit clock fall time	t _{SCKf}	SCK₁	_	100	_	ns		1, 2
			_	_	80	ns		1, 3
Serial output data delay time	t _{DSO}	SO ₁		_	500	ns	Load shown in figure 73	1, 2
			7	_	200	ns	_	1, 3
Serial input data setup time	t _{ssı}	SI ₁	300	٥	_	ns		1, 2
			150		_	ns		1, 3
Serial input data hold time	t _{HSI}	SI ₁	300	1	5	ns		1, 2
			150	_	1	ns		1, 3

Note: 1. Refer to figure 72.

2. Applies to HD404052, HD404054, HD404092, HD404094, HD4074054, HD4074094.

3. Applies to HD40A4052, HD40A4054.

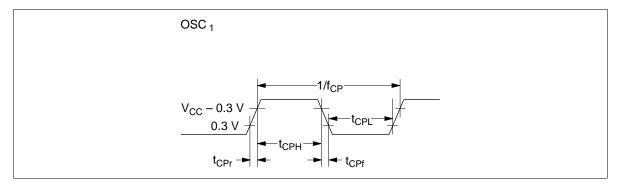


Figure 68 External Clock Timing

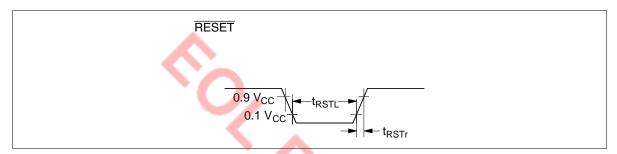


Figure 69 Interrupt Timing

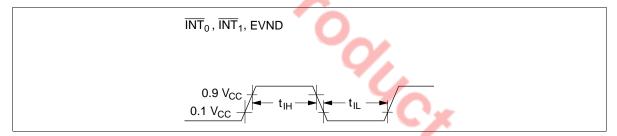


Figure 70 Reset Timing

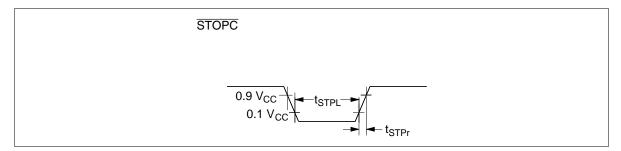


Figure 71 STOPC Timing

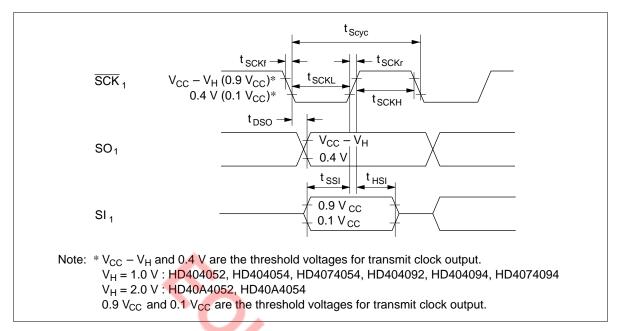


Figure 72 Serial Interface Timing

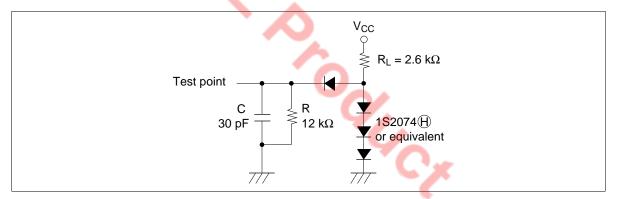


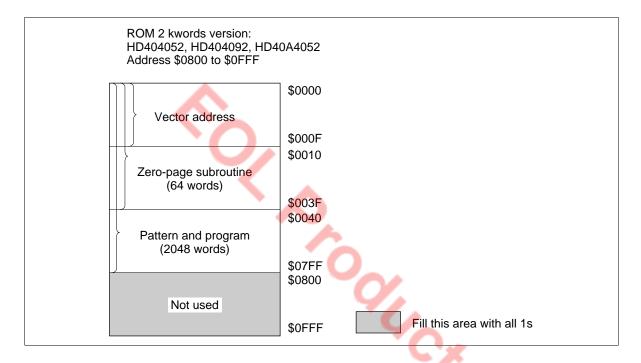
Figure 73 Timing Load Circuit

Notes On ROM Out

Please pay attention to the following items regarding ROM out.

On ROM out, fill the ROM area indicated below with 1s to create the same data size as 4-kword versions (HD404054, HD404094 and HD40A4054). A 4-kword data size is required to change ROM data to mask manufacturing data since the program used is for a 4-kword version.

This limitation apply to the case of using EPROM and the case of using data base.



HD40(A)4052/HD40(A)4054 Option List

Please check off the appropriate applications and enter the necessary information.

	Date of order	/	/	
	Customer			
	Department			
	Name			
HD40A4052: 2-kword	ROM code name			
☐ HD404054: 4-kword ☐ HD40A4054: 4-kword				
crocomputer type (include	ding ZTAT™ version).			
nd low <mark>er</mark> bits are separa different EPROMS.	ated. The upper five bits	s and lower five	bits are	
2				
MHz				
MHz	0			
MHz				
	Olici	ĸ		
		K		
		K		
1	below (the upper bits and crocomputer type (included to the same EPROM in and lower bits are separal different EPROMS.	Department Name HD40A4052: 2-kword HD40A4054: 4-kword Below (the upper bits and lower bits are mixed crocomputer type (including ZTAT TM version). Indicate the same EPROM in alternating order (i.e., and lower bits are separated. The upper five bits different EPROMS.	Department Name HD40A4052: 2-kword HD40A4054: 4-kword Below (the upper bits and lower bits are mixed together), where the computer type (including ZTATTM version). Indicate the same EPROM in alternating order (i.e., LULULU). Indicate the same EPROMS.	

HD404092/HD404094 Option List

Please check off the appro	priate applicati	ions and ente	r the necessary informat	tion.			
			Date of order	/	/		
			Customer				
			Department				
1. ROM size			Name				
☐ HD404092: 2-kword			ROM code name				
☐ HD404094: 4-kword			LSI number				
			and lower bits are mixeo uding ZTAT™ version).	I together), whe	n using		
			d together. The upper fivin alternating order (i.e.,		r five bits		
	bits and lower ed to different E		rated. The upper five bit	s and lower five	bits are		
3. Oscillator for OSC1 and	d OSC2	~	A				
Ceramic oscillator	f =	MHz					
☐ Crystal oscillator	f =	MHz	0				
☐ External clock	f =	MHz					
4. Stop mode			00/10	K			
☐ Not used							
5. Package							
L DP-423							

☐ FP-44A

Cautions

- 1. Hitachi neither warrants nor grants licenses of any rights of Hitachi's or any third party's patent, copyright, trademark, or other intellectual property rights for information contained in this document. Hitachi bears no responsibility for problems that may arise with third party's rights, including intellectual property rights, in connection with use of the information contained in this document.
- 2. Products and product specifications may be subject to change without notice. Confirm that you have received the latest product standards or specifications before final design, purchase or use.
- 3. Hitachi makes every attempt to ensure that its products are of high quality and reliability. However, contact Hitachi's sales office before using the product in an application that demands especially high quality and reliability or where its failure or malfunction may directly threaten human life or cause risk of bodily injury, such as aerospace, aeronautics, nuclear power, combustion control, transportation, traffic, safety equipment or medical equipment for life support.
- 4. Design your application so that the product is used within the ranges guaranteed by Hitachi particularly for maximum rating, operating supply voltage range, heat radiation characteristics, installation conditions and other characteristics. Hitachi bears no responsibility for failure or damage when used beyond the guaranteed ranges. Even within the guaranteed ranges, consider normally foreseeable failure rates or failure modes in semiconductor devices and employ systemic measures such as fail-safes, so that the equipment incorporating Hitachi product does not cause bodily injury, fire or other consequential damage due to operation of the Hitachi product.
- 5. This product is not designed to be radiation resistant.
- 6. No one is permitted to reproduce or duplicate, in any form, the whole or part of this document without written approval from Hitachi.
- Contact Hitachi's sales office for any questions regarding this document or Hitachi semiconductor products.